



## Industrial NC2702MA

### 28V Synchronous Buck 6A Switching Regulator with Built-in Inductor/MOSFET

#### FEATURES

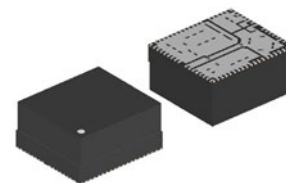
- Input Voltage (Maximum Rating): 4.0 V to 28 V (29 V)
- Operating Temperature Range: -40 °C to 85 °C
- Start-Up Voltage: 4.5 V
- Output Voltage: 0.7 V to 5.3 V
- Feedback Voltage Tolerance:  $0.64 \text{ V} \pm 1 \%$
- Oscillation Frequency: 250 kHz to 1 MHz
- Minimum On-Time: Typ. 100 ns
- Minimum OFF-Time: Typ. 120 ns (at regulation mode)  
At dropout, actual minimum off-time is reduced.
- Duty-Over: Min. 1/4
- Soft-Start
- Power-Good
- Thermal Shutdown
- Under Voltage Lockout (UVLO) Function:  
VCC = 3.3 V (Typ.)
- Overvoltage Detection (OVD),  
Undervoltage Detection (UVD)
- High-Side MOSFET ON-Resistance: 9.7mΩ
- Low-Side MOSFET ON-Resistance: 4.7mΩ

#### APPLICATIONS

- POL converter of FPGA
- Communication Base Stations, Network Servers
- Industrial Embedded Control Equipment, Medical Embedded Control Equipment

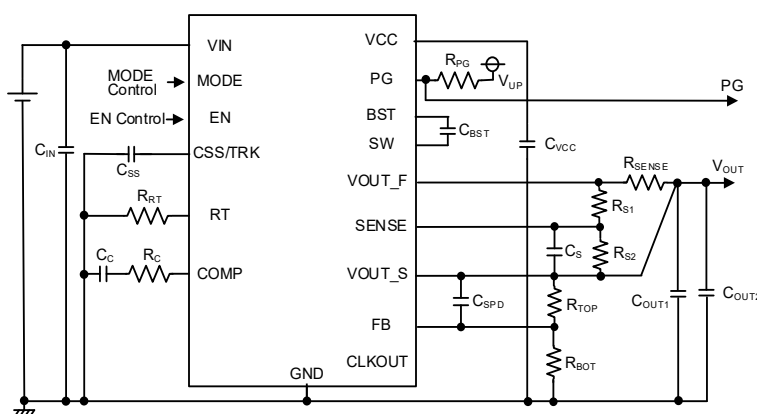
#### GENERAL DESCRIPTION

The NC2702MA is a 6 A synchronous step-down switching regulator module with a maximum input of 28 V that incorporates CMOS-based DC / DC controller IC, MOSFETs, and 2.2μH (DCR Typ. 13.7 mΩ) inductor. The space-saving power supply design is easy with the NC2702MA. Also, the switching frequency can be adjusted in the range from 250 kHz to 1 MHz by an external resistor. This product is a high-reliability device for industrial application, that has passed both the inspection at high temperature and the reliability test for considering industrial equipment.



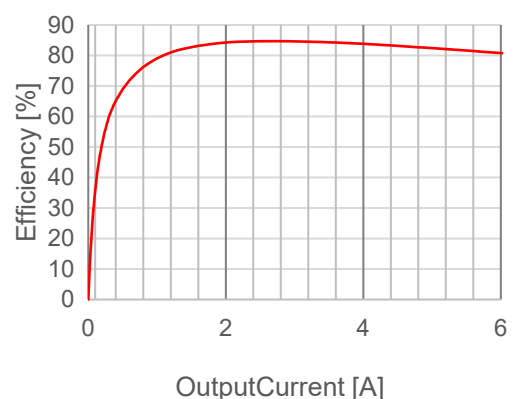
**QFN0910-65-MA**  
**10.0 x 9.0 x 4.8mm**

#### TYPICAL APPLICATIONS



**NC2702MA TYPICAL APPLICATIONS**

#### EFFICIENCY TYPICAL CHARACTERISTICS



**NC2702MA Efficiency Characteristics**  
**V<sub>IN</sub>=12V V<sub>OUT</sub>=1V F<sub>osc</sub>=400kHz**

## PRODUCT NAME INFORMATION

**NC2702 aa bbb c dd e**

## Description of Configuration

| Composition | Item           | Description  |
|-------------|----------------|--|
| aa          | Package code   | Indicates the package. Please refer to the ORDER INFORMATION.<br>MA: MCM Type Module |
| bbb         | Output Voltage | External Setting Type: 000 only  |
| c           | Version        | Select the Overcurrent Protection type   |
| dd          | Packing        | Taping direction.<br>Refer to the packing specifications.                            |
| e           | Grade          | Indicates the quality grade.<br>D: Industrial Equipment                              |

## Version

| c | Overcurrent Protection  |
|---|-------------------------|
| A | Non-Latch Type (Hiccup) |
| B | Latch Type              |

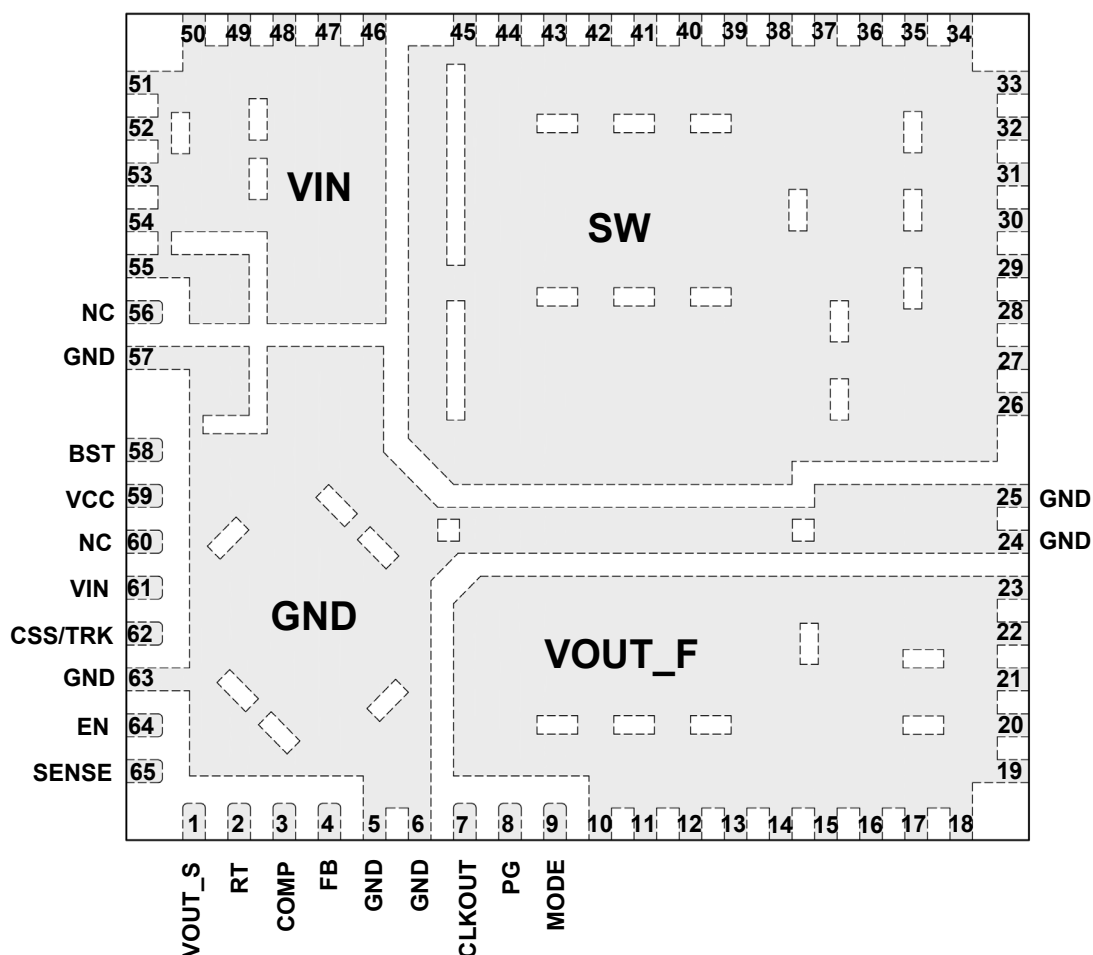
## Grade

| e | Applications                                    | Operating Temperature Range | Test Temperature |
|---|---|-----------------------------|------------------|
| D | Industrial Equipment and Social Infrastructures | -40°C to 85°C               | 25°C, 85°C       |

## ORDER INFORMATION

| PRODUCT NAME    | PACKAGE       | RoHS | HALOGEN-FREE | PLATING COMPOSITION | WEIGHT (mg) | QUANTITY (pcs/reel) |
|-----------------|---------------|------|--------------|---------------------|-------------|---------------------|
| NC2702MA000AE2D | QFN0910-65-MA | Yes  | Yes          | Sn2Bi               | 1563        | 250                 |
| NC2702MA000BE2D | QFN0910-65-MA | Yes  | Yes          | Sn2Bi               | 1563        | 250                 |

# PIN DESCRIPTIONS



QFN0910-65-MA Pin Configuration

※This is a pin layout image diagram (Top view)

## Pin Descriptions

| Pin No.  | Pin Name | I/O   | Description  |
|----------|----------|-------|--|
| 1        | VOUT_S   | I     | Output Voltage Feedback Input Pin  |
| 2        | RT       | I     | Oscillation Adjustment Pin<br>Connecting a resistor to ground from this pin sets the switching frequency.<br>Switching frequency range is from 250 kHz to 1 MHz. |
| 3        | COMP     | I     | A Phase Compensation network connected Pin.<br>Connect a capacitor and a resistor to compensate the loop.  |
| 4        | FB       | I     | Feedback Input Pin<br>Set the output voltage by connecting an external resistor.   |
| 5, 6     | GND      | -     | GND Pin ※Be sure to tie these pins on the board.   |
| 7        | CLKOUT   | O     | Clock Output Pin<br>Clock output pin synchronized with internal switching frequency.<br>CMOS output with VCC as power supply.                                    |
| 8        | PG       | O     | Power-Good Output Pin<br>NMOS open drain pin.<br>Output that is pulled-up node "High" in normal state.   |
| 9        | MODE     | I     | Mode-Select Input Pin<br>High: to select Forced PWM Control, External Clock Synchronization with PLL Input.<br>Low: prohibited                                   |
| 10 to 23 | VOUT_F   | O     | Power Output Pin<br>Mount the RSENSE for Peak Current Limit between the Vout load and these pins .   |
| 24, 25   | GND      | —     | GND Pin ※ Connect these pins together on the board.  |
| 26 to 45 | SW       | O     | Switching Pin<br>The inductor is connected inside the IC to this pin. To enforce the power dissipation, refer to the footprint and PCB layout.                   |
| 46 to 55 | VIN      | Power | Power Supply Input Pin ※ Be sure to connect the VIN pins together on the board.  |
| 56, 60   | NC       | —     | No Connection<br>It is recommended to be left open to reduce the risk of adjacent pins' short.   |
| 57, 63   | GND      | —     | GND Pin ※Be sure to connect the GND pins together on the board.  |
| 58       | BST      | I     | Bootstrapped Pin<br>By connecting a capacitor ( $C_{BST}$ ) between the SW and BST pin, the voltage between the SW and BST pin is controlled to Typ.5V.          |
| 59       | VCC      | O     | VCC Output Pin   |
| 61       | VIN      | Power | Power Supply Input Pin ※ Be sure to connect the VIN pins together on the board.  |
| 62       | CSS/TRK  | I     | Soft-Start Adjustment Pin<br>Soft-start time can be adjusted by connecting a capacitor between this pin and GND.   |
| 64       | EN       | I     | Enable Pin ("High" active)<br>Input "Low" to this pin shuts down the IC. Input "High" to this pin enables the IC.  |
| 65       | SENSE    | I     | Sense Pin for Inductor Current   |

For details, refer to "[TYPICAL APPLICATION CIRCUIT](#)" and "[THEORY OF OPERATION](#)".

## ABSOLUTE MAXIMUM RATINGS

|                                    | Symbol        | Ratings                        | Unit |
|------------------------------------|---------------|--------------------------------|------|
| Input Voltage                      | $V_{IN}$      | -0.3 to 29                     | V    |
| EN Pin Input Voltage               | $V_{EN}$      | -0.3 to $V_{IN} + 0.3 \leq 29$ | V    |
| CSS/TRK Pin Input Voltage          | $V_{CSS/TRK}$ | -0.3 to 3                      | V    |
| VOUT_S Pin Voltage                 | $V_{OUT\_S}$  | -0.3 to 6                      | V    |
| VOUT_F Pin Voltage                 | $V_{OUT\_F}$  | -0.3 to 6                      | V    |
| SENSE Pin Voltage                  | $V_{SENSE}$   | -0.3 to 6                      | V    |
| RT Pin Voltage                     | $V_{RT}$      | -0.3 to 3                      | V    |
| COMP Pin Voltage                   | $V_{COMP}$    | -0.3 to $V_{CC} + 0.3 \leq 6$  | V    |
| FB Pin Voltage                     | $V_{FB}$      | -0.3 to 3                      | V    |
| VCC Pin Voltage                    | $V_{CC}$      | -0.3 to 6                      | V    |
| Output Current for VCC Pin         |               | Internally limited             | mA   |
| BST Pin Voltage                    | $V_{BST}$     | SW-0.3 to SW+6                 | V    |
| SW Pin Voltage                     | $V_{SW}$      | -0.3 to $V_{IN} + 0.3 \leq 29$ | V    |
| MODE Pin Voltage                   | $V_{MODE}$    | -0.3 to 6                      | V    |
| PG Pin Voltage                     | $V_{PG}$      | -0.3 to 6                      | V    |
| CLKOUT Pin Voltage                 | $V_{CLKOUT}$  | -0.3 to $V_{CC} + 0.3 \leq 6$  | V    |
| Junction Temperature <sup>*1</sup> | $T_j$         | -40 to 150                     | °C   |
| Storage Temperature Range          | $T_{stg}$     | -55 to 150                     | °C   |

## ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

<sup>\*1</sup> Calculate the power consumption of the IC from the operating conditions and calculate the junction temperature with the thermal resistance.

Please refer to "[THERMAL CHARACTERISTICS](#)" for the thermal resistance under our measurement board conditions.

**ELECTROSTATIC DISCHARGE RATINGS**

|     | Conditions             | Protection Voltage |
|-----|------------------------|--------------------|
| HBM | C = 100 pF, R = 1.5 kΩ | ±2000 V            |
| CDM |                        | ±1000 V            |

**ELECTROSTATIC DISCHARGE RATINGS**

The electrostatic discharge test is done based on JESD47.

In the HBM method, ESD is applied using the power supply pin and GND pin as reference pins.

**RECOMMENDED OPERATING CONDITIONS**

|                             | Symbol           | Ratings    | Unit |
|-----------------------------|------------------|------------|------|
| Input Voltage               | V <sub>IN</sub>  | 4.0 to 28  | V    |
| Operating Temperature Range | T <sub>a</sub>   | −40 to 85  | °C   |
| Output Voltage              | V <sub>OUT</sub> | 0.7 to 5.3 | V    |
| Output Current (NC2702MA)   | I <sub>OUT</sub> | 0 to 6     | A    |

**RECOMMENDED OPERATING CONDITIONS**

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

## ELECTRICAL CHARACTERISTICS

$V_{IN} = 12\text{ V}$ ,  $V_{EN} = V_{IN}$  unless otherwise specified.

For parameter that does not describe the temperature condition, the MIN / MAX value under the condition of  $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$  is described.

## NC2702MA000xE2D

| Parameter  | Symbol            | Conditions   | MIN                  | TYP             | MAX                  | Unit             |
|--|-------------------|--|----------------------|-----------------|----------------------|------------------|
| Start-Up Voltage                                 | $V_{START}$       |  |                      |                 | 4.5                  | V                |
| VCC Pin Voltage (VCC-GND)                        | $V_{CC}$          | $V_{IN} = 28\text{ V}$ , $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$  | 4.9                  | 5.1             | 5.3                  | V                |
| Shutdown Current                                 | $I_{sd}$          | $V_{IN} = 28\text{ V}$ , $V_{EN} = 0\text{ V}$   |                      | 3               | 20                   | $\mu\text{A}$    |
| Quiescent Current<br>at no switching in PWM Mode | $I_Q$             | $V_{IN} = 12\text{ V}$ , $V_{FB} = 0.672\text{ V}$ ,<br>$V_{OUT\_S} = V_{SENSE} = 1.5\text{ V}$ ,<br>$V_{SW} = 1.5\text{ V}$ |                      | 1.2             | 1.9                  | mA               |
| UVLO Release Voltage                             | $V_{UVLOREL}$     | $V_{IN} = V_{CC} = \text{Low to High}$   | 3.85                 | 4.0             | 4.2                  | V                |
| UVLO Detection Voltage                           | $V_{UVLODET}$     | $V_{IN} = V_{CC} = \text{High to Low}$   | 3.1                  | 3.3             | 3.4                  | V                |
| FB Voltage Accuracy                              | $V_{FB}$          | $V_{IN} = 12\text{ V}$ , $T_a = 25^{\circ}\text{C}$  | 0.6336               | 0.64            | 0.6464               | V                |
|  |                   | $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$   | 0.6272               |                 | 0.6528               |                  |
| Oscillation Frequency 0                          | $f_{OSC0}$        | $R_{RT} = 135\text{ k}\Omega$  | 225                  | 250             | 275                  | kHz              |
| Oscillation Frequency 1                          | $f_{OSC1}$        | $R_{RT} = 32\text{ k}\Omega$   | 900                  | 1000            | 1100                 | kHz              |
| Minimum OFF Time                                 | $t_{OFF}$         | $V_{IN} = 5\text{ V}$ , $V_O = 5\text{ V}$   |                      | 120             | 190                  | ns               |
| Minimum ON Time                                  | $t_{ON}$          | $V_{IN} = 5\text{ V}$ , $V_O = 0.7\text{ V}$   |                      | 100             | 120                  | ns               |
| Synchronizing Frequency                          | $f_{SYNC}$        | $f_{OSC}$ Criteria   | $f_{OSC} \times 0.5$ |                 | $f_{OSC} \times 1.5$ | kHz              |
|  |                   |  | 250                  |                 | 1000                 | kHz              |
| Soft-Start Time 1                                | $t_{SS1}$         | $V_{IN} = 12\text{ V}$ , $CSS/TRK = \text{OPEN}$   | 0.4                  |                 | 0.75                 | ms               |
| Soft-Start Time 2                                | $t_{SS2}$         | $V_{IN} = 12\text{ V}$ , $C_{SS} = 4.7\text{ nF}$  | 1.4                  |                 | 2.0                  | ms               |
| Charge Current for Soft-Start Pin                | $I_{TSS}$         | $V_{IN} = 12\text{ V}$ , $V_{CSS/TRK} = 0\text{ V}$  | 1.8                  | 2               | 2.2                  | $\mu\text{A}$    |
| CSS/TRK Pin Voltage at<br>End of Soft-Start      | $V_{SSEND}$       |  | $V_{FB}$             | $V_{FB} + 0.03$ | $V_{FB} + 0.06$      | V                |
| Discharge FET<br>On-resistance for CSS/TRK Pin   | $R_{ONDISD\_CSS}$ | $V_{IN} = 4.5\text{ V}$ , $V_{EN} = 0\text{ V}$ ,<br>$V_{CSS/TRK} = 3\text{ V}$  | 2.0                  | 3.0             | 5.0                  | $\text{k}\Omega$ |

All electrical characteristic parameters that specify the minimum and maximum specifications are tested under the condition of  $T_j \approx T_a = 25^{\circ}\text{C} / 85^{\circ}\text{C}$

$V_{IN} = 12\text{ V}$ ,  $V_{EN} = V_{IN}$  unless otherwise specified.

For parameter that do not describe the temperature condition, the MIN / MAX value under the condition of  $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$  is described.

#### NC2702MA000xE2D

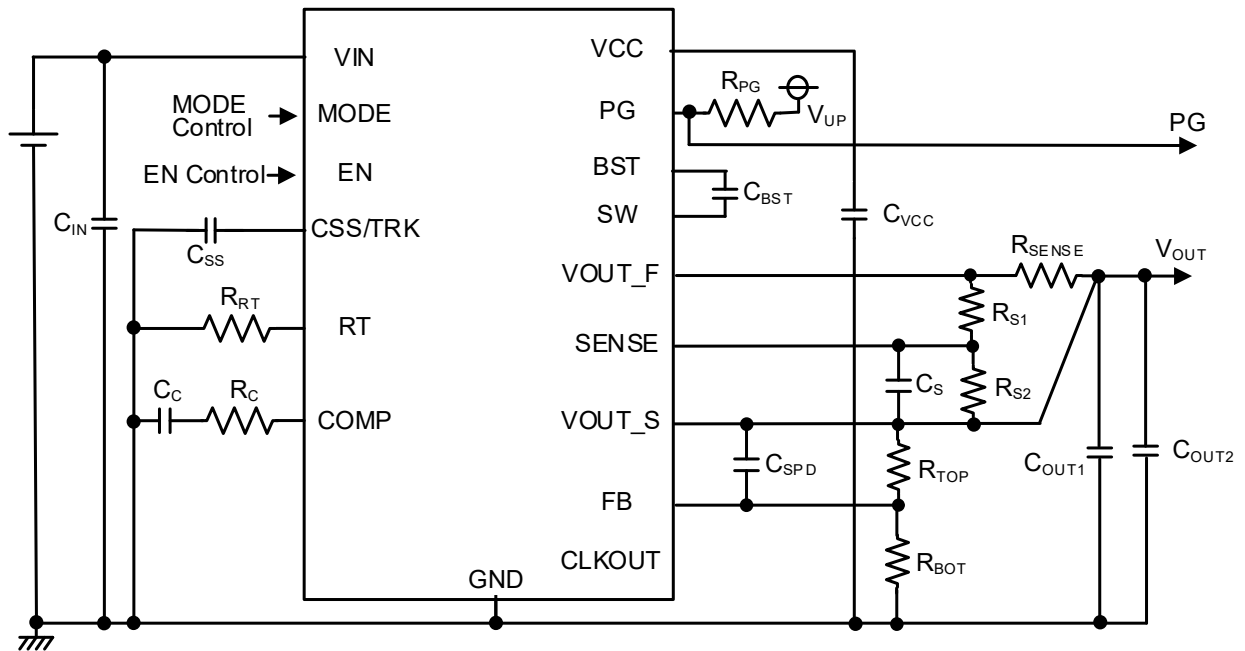
| Parameter  | Symbol           | Conditions   | MIN   | TYP                  | MAX   | Unit               |
|--|------------------|--|-------|----------------------|-------|--------------------|
| Current Limit Threshold Voltage (SENSE – VOUT_S)         | $V_{LIMIT}$      |  | 40    | 50                   | 60    | mV                 |
| Reverse Current Sense Threshold Voltage (SENSE – VOUT_S) | $V_{IREVLIMIT}$  |  | 40    | 50                   | 60    | mV                 |
| SW Short to GND Detector Threshold Voltage (VIN – SW)    | $V_{SWSHORTDET}$ |  | 0.345 | 0.43                 | 0.520 | V                  |
| SW Short to VCC Detector Threshold Voltage (SW – GND)    | $V_{SWSHORTDET}$ |  | 0.330 | 0.43                 | 0.515 | V                  |
| EN Input High Voltage                                    | $V_{ENH}$        | $V_{IN} = V_{CE} = 28\text{ V}$                            | 1.30  |                      |       | V                  |
| EN Input Low Voltage                                     | $V_{ENL}$        | $V_{IN} = 28\text{ V}$ , $V_{CE} = 0\text{ V}$             |       |                      | 1.10  | V                  |
| EN Input High Current                                    | $I_{ENH}$        | $V_{EN} = 28\text{ V}$                                     | 0.20  |                      | 2.45  | $\mu\text{A}$      |
| FB Input High Current                                    | $I_{FBH}$        | $V_{IN} = 28\text{ V}$ , $V_{FB} = 3\text{ V}$             | -0.1  | 0                    | 0.1   | $\mu\text{A}$      |
| FB Input Low Current                                     | $I_{FBL}$        | $V_{IN} = 28\text{ V}$ , $V_{FB} = 0\text{ V}$             | -0.1  | 0                    | 0.1   | $\mu\text{A}$      |
| MODE Input High Voltage                                  | $V_{MODEH}$      | $V_{IN} = 28\text{ V}$                                     | 1.33  |                      |       | V                  |
| MODE Input High Current                                  | $I_{MODEH}$      | $V_{IN} = 28\text{ V}$ , $V_{MODE} = 6\text{ V}$           | 1.00  |                      | 6.60  | $\mu\text{A}$      |
| CLKOUT Output High Voltage                               | $V_{CLKOUTH}$    | CLKOUT = Hi-Z  | 4.7   |                      | VCC   | V                  |
| CLKOUT Output Low Voltage                                | $V_{CLKOUTL}$    | CLKOUT = Hi-Z  | 0     |                      | 0.1   | V                  |
| PG Output Low Voltage                                    | $V_{PGOFF}$      | $V_{IN} = 4.0\text{ V}$ ,<br>$I_{PG} = 1\text{ mA}$        |       | 0.26                 | 0.54  | V                  |
| PG Pin Leakage Current                                   | $I_{PGOFF}$      | $V_{IN} = 28\text{ V}$ ,<br>$V_{PG} = 6\text{ V}$          | -0.1  | 0                    | 0.1   | $\mu\text{A}$      |
| FB Pin OVD Threshold Voltage                             | $V_{FBOVDDET}$   | $V_{IN} = 5.0\text{ V}$ ,<br>$V_{FB} = \text{Low to High}$ | 0.680 | $V_{FB} \times 1.10$ | 0.740 | V                  |
|  | $V_{FBOVDREL}$   | $V_{IN} = 5.0\text{ V}$ ,<br>$V_{FB} = \text{High to Low}$ | 0.664 | $V_{FB} \times 1.07$ | 0.712 | V                  |
| FB Pin UVD Threshold Voltage                             | $V_{FBUVDDET}$   | $V_{IN} = 5.0\text{ V}$ ,<br>$V_{FB} = \text{High to Low}$ | 0.556 | $V_{FB} \times 0.90$ | 0.604 | V                  |
|  | $V_{FBUVDREL}$   | $V_{IN} = 5.0\text{ V}$ ,<br>$V_{FB} = \text{Low to High}$ | 0.574 | $V_{FB} \times 0.93$ | 0.628 | V                  |
| Thermal Shutdown Detection Temperature                   | $T_{SDDET}$      | $T_j^{*1} = \text{Low to High}$                            | -     | 130                  | -     | $^{\circ}\text{C}$ |
| Thermal Shutdown Release Temperature                     | $T_{SDREL}$      | $T_j^{*1} = \text{High to Low}$                            | -     | 110                  | -     | $^{\circ}\text{C}$ |

All electrical characteristic parameters that specify the minimum and maximum specifications are tested under the condition of  $T_j \approx T_a = 25^{\circ}\text{C} / 85^{\circ}\text{C}$

\*1 This product is a module product.  $T_j$  is the junction temperature of the controller chip.

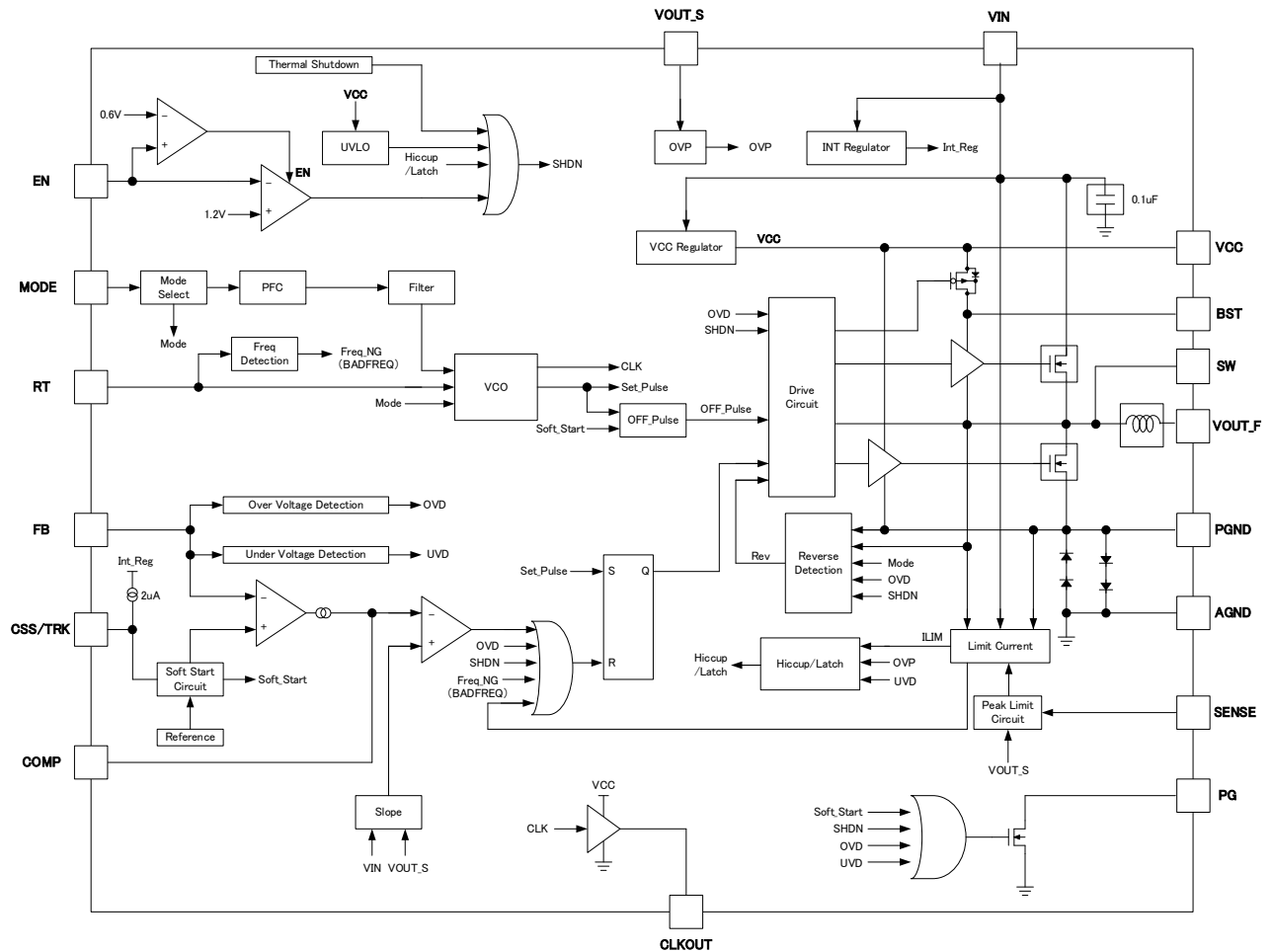


## TYPICAL APPLICATION CIRCUIT



NC2702MA Typical Application Circuit

## BLOCK DIAGRAMS

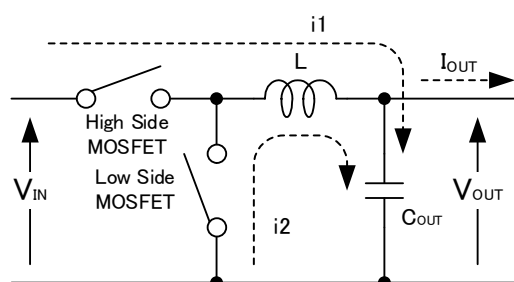


NC2702MA Block Diagram

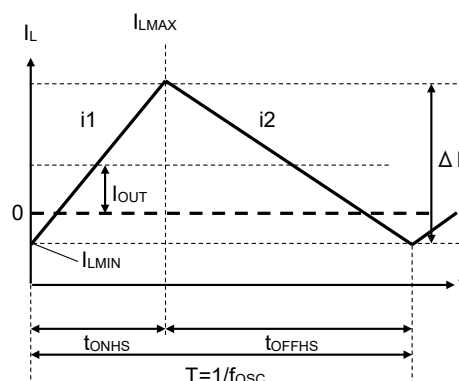
## THEORY OF OPERATION

### Operation of Step-Down Switching Regulator

A basic step-down switching regulator is illustrated in the following figures. This switching regulator charges energy in the inductor when the high-side MOSFET turns on and discharges the energy from the inductor when the high-side MOSFET turns off and controls with less energy loss, so that a lower output voltage than the input voltage is obtained.



Basic Circuit



Current Through Inductor

- Step1. The high-side MOSFET turns on and current  $I_L (= i1)$  flows, and energy is charged into  $C_{OUT}$ . At this moment,  $I_L$  increases from  $I_{LMIN} (= 0)$  to reach  $I_{LMAX}$  in proportion to the on-time period ( $t_{ONHS}$ ) of the high-side MOSFET turns on and current  $I_L (= i1)$  flows, and energy is charged into  $C_{OUT}$ . At this moment,  $I_L$  increases from  $I_{LMIN} (= 0)$  to reach  $I_{LMAX}$  in proportion to the on-time period ( $t_{ONHS}$ ) of the high-side MOSFET.
- Step2. When the high-side MOSFET turns off, the low-side MOSFET turns on in order to maintain  $I_L$  at  $I_{LMAX}$ , and current  $I_L (= i2)$  flows
- Step3. The low-side MOSFET is turned on until the next cycle. That is, the low-side MOSFET must keep turning on to meet.  $I_L = I_{LMIN} < 0$ , when reaches  $I_L = I_{LMIN} = 0$  after a time of  $t_{OPEN}$ .

In the PWM mode, the output voltage is maintained constant by controlling  $t_{ONHS}$  with the constant switching frequency ( $f_{osc}$ ).

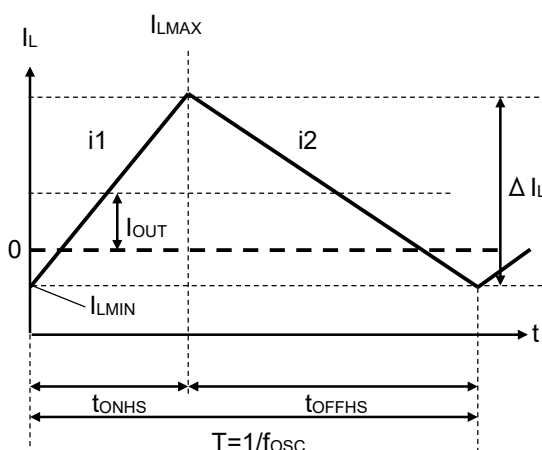
### MODE Pin Function

The forced PWM mode is selected when the voltage of the MODE pin is more than 1.33 V, and the PWM works regardless of a load current. By inputting a clock signal, PLL synchronous mode appears and always operates in PWM regardless of the load current. (The "Low" level input is prohibited.)

See Forced PWM mode for details and Frequency Synchronization Function for the operation on connecting an external clock.

## Forced PWM Mode

Forced PWM mode is selected by setting the fixing the MODE pin to 1.33V or higher or by applying an external clock signal. This mode can reduce the output noise since the frequency is fixed even if the light load conditions. Thus,  $I_{L\min}$  becomes less than "0" when  $I_{OUT}$  is less than  $\Delta I_L / 2$ . That is, the electric charged to  $C_{OUT}$ , is discharged via MOSFET for the durations – when  $I_L$  reaches "0" from  $I_{L\min}$  and when  $I_L$  reaches  $I_{L\min}$  from "0". But, pulse skip is occurred to prevent the overvoltage if high-side MOSFET is turned on when the output voltage is more than the set output voltage.



Forced PWM Mode

## Frequency Synchronization Function

The NC2702MA can synchronize to the external clock being inputted via the MODE pin, with using a PLL (Phase-locked loop). In this case, the forced PWM mode is also in valid. Each High/Low period of the external clock is required at least 100 ns or more. The allowable range of oscillation frequency is from 0.5 to 1.5 times of the set frequency<sup>(2)</sup>, and the operating guaranteed frequency is in the 250 kHz to 1 MHz range<sup>(3)</sup>. The NC2702MA can synchronize to the external clock also during the soft start. That is, the NC2702MA executes the soft-start with the synchronization functions if an external clock is input to the MODE pin and started up. However, if the device is on the maximum duty or the duty-over state caused by small difference between input and output voltages, the device may run at asynchronous to the MODE pin, and it may operate in the frequency in the range from one-fourth to same as the external clock frequency. Likewise, the CLKOUT pin becomes asynchronous to the MODE pin. If making synchronization to the MODE pin, consideration of the minimum difference between input and output voltage for this function is necessary.

## Output Voltage Setting

The output voltage ( $V_{OUT}$ ) can be set by adjustable values of  $R_{TOP}$  and  $R_{BOT}$ . The value of  $V_{OUT}$  can be calculated by Equation 1.

$$V_{OUT} = V_{FB} \times (R_{TOP} + R_{BOT}) / R_{BOT} \quad (\text{Equation 1})$$

For example, when setting  $V_{OUT} = 3.3 \text{ V}$  and setting  $R_{BOT} = 22 \text{ k}\Omega$ ,  $R_{TOP}$  can be calculated by substituting them to Equation 1. As a result of the expanding Equation 2,  $R_{TOP}$  can be set to 91.4 k $\Omega$ . To make 91.4 k $\Omega$  with using the E24 type resistors, the connecting use of 91 k $\Omega$  and 0.39 k $\Omega$  resistors in series is required. If the tolerance level of the set output voltage is wide, using a resistor of 91 k $\Omega$  to  $R_{TOP}$  can reduce the number of components.

$$\begin{aligned} R_{TOP} &= (3.3 \text{ V} / 0.64 \text{ V} - 1) \times 22 \text{ k}\Omega \\ &= 91.4 \text{ k}\Omega \quad (\text{Equation 2}) \end{aligned}$$

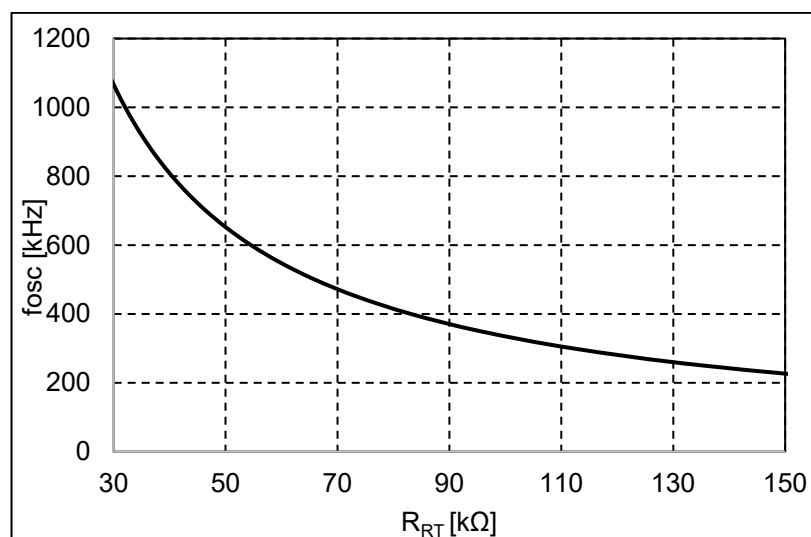
<sup>(2)</sup> See *Oscillation Frequency Setting* for details of the set frequency.

<sup>(3)</sup> The adjustable oscillation frequency range becomes  $250\text{kHz} \leq f_{OSC} \leq 600\text{kHz}$  when  $0.7 \text{ V} \leq V_{OUT} < 1.35\text{V}$ .

## Oscillation Frequency Setting

Connecting the oscillation frequency setting resistor ( $R_{RT}$ ) between the RT pin and GND can control the oscillation frequency in the range of 250 kHz to 1 MHz<sup>\*4</sup>. For example, using the resistor of 66 k $\Omega$  can set the frequency of about 500 kHz.

The Electrical Characteristics guarantees the oscillation frequency for  $f_{OSC0}$  (at  $R_{RT} = 135 \text{ k}\Omega$ ) and  $f_{OSC1}$  (at  $R_{RT} = 32 \text{ k}\Omega$ ).



$$R_{RT} [\text{k}\Omega] = 41993 \times f_{osc} [\text{kHz}]^{-1.039}$$

NC2702MA Oscillation Frequency Setting Resistor ( $R_{RT}$ ) vs. Oscillation Frequency ( $f_{osc}$ )

## Duty-Over Function

When the input voltage is down by cranking, the operating frequency is reduced until one-fourth of the set frequency with being linearly proportional to time in order to maintain the output voltage. Exploiting the ON duty to exceed the maxduty value at normal operation can allow the small difference between input and output voltages.

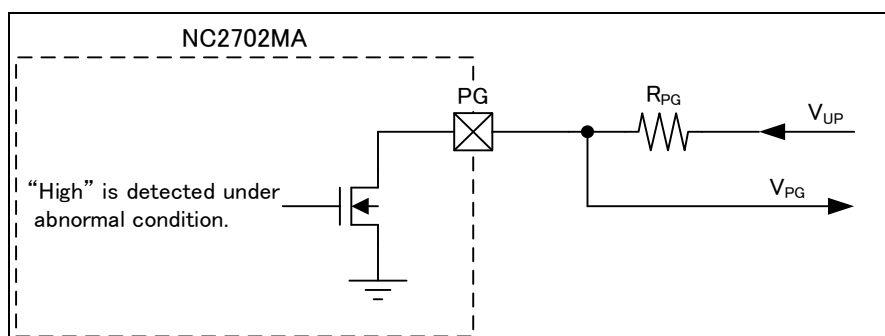
## Power Good Output Function

The power good function with using an NMOS open drain output can detect the following states of the NC2702MA. The NMOS turns on and the PG pin being Low, when detecting the items shown below. After the NC2702MA returns to the normal state, the NMOS turns off and the PG pin outputs High (PG Input Voltage:  $V_{UP}$ ).

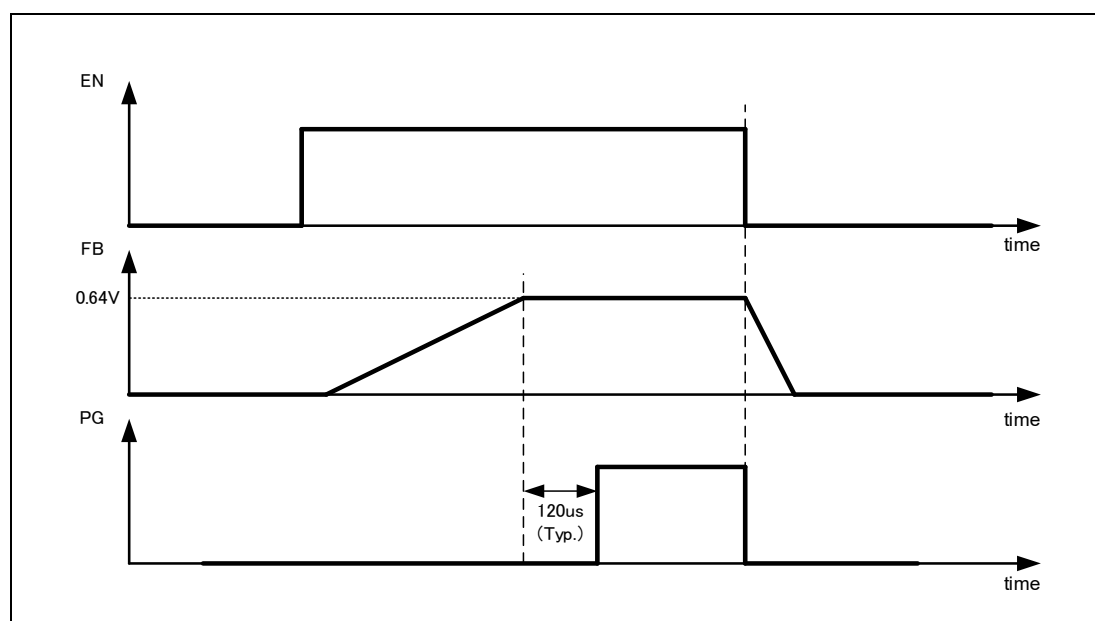
- EN = "Low" (Shut Down)
- UVLO(Shut Down)
- Thermal Shut Down
- Soft-Start Time
- At UVD Threshold Voltage Detection
- At OVD Threshold Voltage Detection
- At Hiccup-Type Protection (when hiccup mode is selected)
- At Latch-Type Protection (when latch mode is selected)

<sup>\*4</sup> The adjustable oscillation frequency range becomes  $250 \text{ kHz} \leq f_{osc} \leq 600 \text{ kHz}$  if  $.7 \text{ V} \leq V_{OUT} < 1.35 \text{ V}$ .

The PG pin is designed to become 0.54 V or less in Low level when the current flowing to the PG pin is 1 mA. The use of the PG input voltage ( $V_{UP}$ ) of 5.5 V or less and the pull-up resistor ( $R_{PG}$ ) of 10 k $\Omega$  to 100 k $\Omega$  are recommended. If not using the PG pin, connect it to GND or left open.



Power Good Output Pin Connecting Diagram

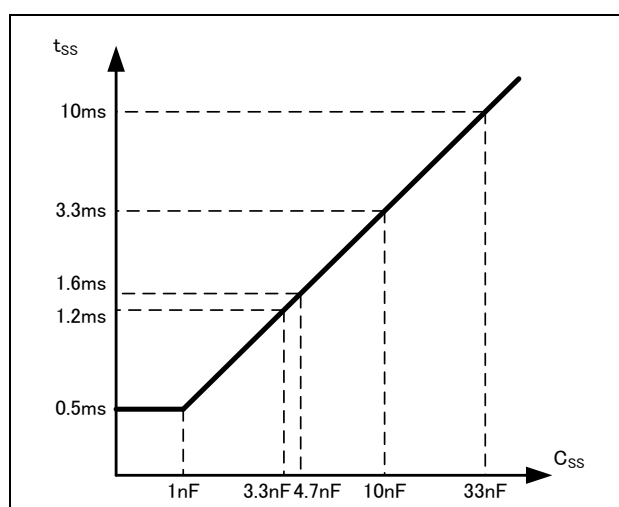


Rising / Falling Sequence of Power Good Circuit

## Soft-Start Function

The soft-start time is a time between a rising edge ("High" level) of the EN pin and the timing when the output voltage reaches the set output voltage. Connecting a capacitor (C<sub>SS</sub>) to the CSS / TRK pin can adjust the soft-start time (t<sub>ss</sub>) – provided the internal soft-start time of 500 μs (Typ.) as a lower limit. The adjustable soft-start time is 1.6 ms (Typ.) when connecting an external capacitor of 4.7 nF. The time is for charging a capacitor up to 0.64V(Typ.) with the charging current of 2.0 μA (Typ.). If not required to adjust the soft-start time, by the CSS / TRK pin being "Open", the internal soft-start time of 500 μs (Typ.) is set. If connecting a large capacitor to an output signal, the overcurrent protection or the SW GND short protection might run. To avoid these protections caused by starting abruptly when reducing the amount of power current, soft-start time must be set as long as possible.

Each of soft-start time (t<sub>ss1</sub>/ t<sub>ss2</sub>) is guaranteed under the conditions described in the chapter of "Electrical Characteristics".

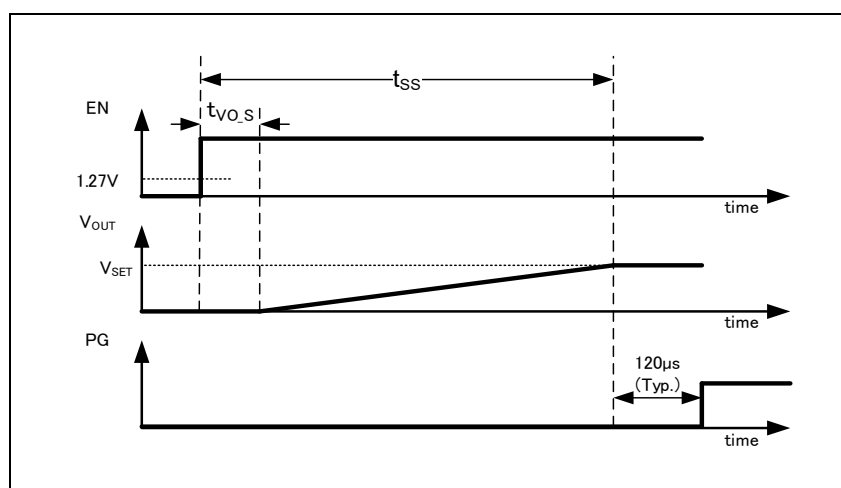


$$C_{SS} [\text{nF}] = (t_{ss} - t_{VO\_S}) / 0.64 \times 2.0$$

t<sub>ss</sub>: Soft-Start Time (ms)

t<sub>VO\_S</sub>: Time period from EN = "High" to V<sub>OUT</sub>'s rising  
(Typ. 0.160ms)

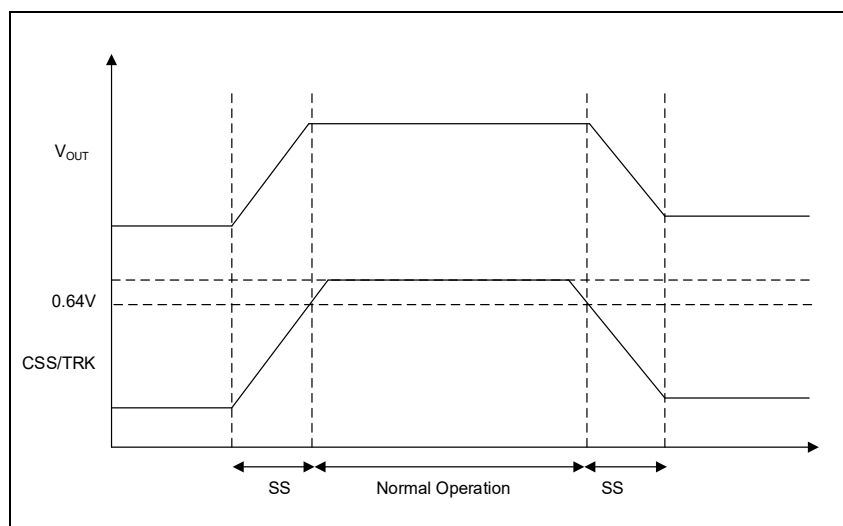
Soft-Start Time Adjustable Capacitor (C<sub>SS</sub>) vs. Soft-Start Time (t<sub>ss</sub>)



Soft-Start Sequence

## Tracking Function

Applying an external tracking voltage to the CSS / TRK pin can control the soft-start sequence – provided that the lowest internal soft-start time is limited to 500  $\mu$ s (Typ.). Since the FB pin voltage,  $V_{FB}$  becomes nearly equal to  $V_{CSS/TRK}$  at tracking, the complex start timing and soft-start can be easily designed. The available voltage at tracking is between 0 V and 0.64 V. If the tracking voltage is over 0.64 V, the internal reference voltage of 0.64 V is enabled. Also, an arbitrary falling waveform can be generated by reducing  $V_{CSS/TRK}$  to 0.64 V (Typ.) or less, because the NC2702MA supports both of up- and down- tracking.



Tracking Sequence

## Min. ON-Time

The min. ON time (Max. 120 ns), which is determined in the NC2702MA internal circuit, is a minimum time to turn high-side MOSFET on. The NC2702MA cannot generate a pulse width less than the min. ON time. Therefore, settings of the output set voltage and the oscillator frequency are required so that the minimum step-down ratio [ $V_{OUT}/V_{IN} \times (1 / f_{OSC})$ ] does not stay below 120ns. If staying below 120 ns, the pulse skipping operation appears to stabilize the output voltage. The ripple current and the output voltage ripple will be large under the pulse skipping condition.

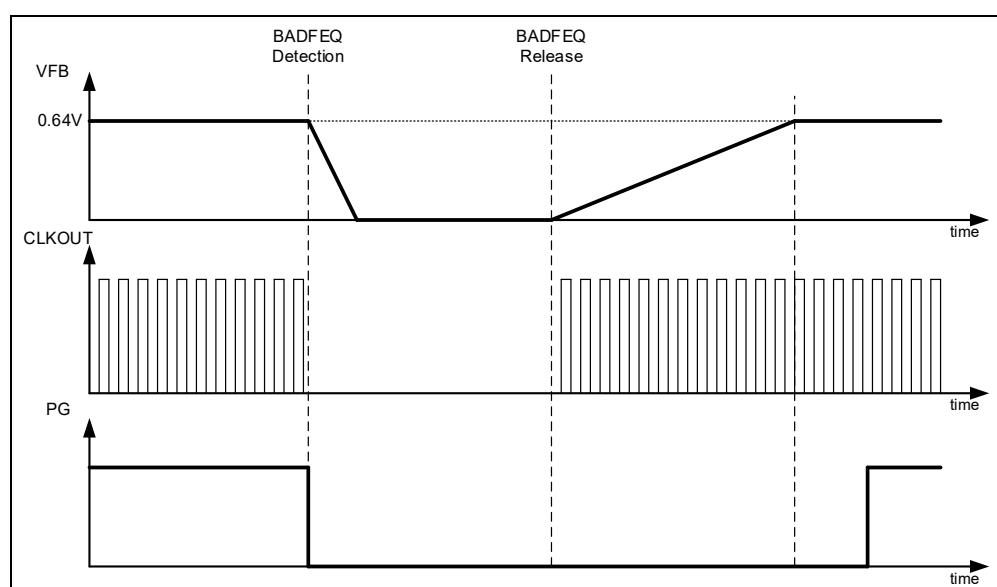
## Min. OFF-Time

By the adoption of bootstrap circuit, the high-side MOSFET, which is used as the NC2702MA, is used an NMOS. The sufficient voltage to drive the high-side MOSFET must be charged. Therefore, the min. OFF time is determined from the required time to charge the voltage. By the function of the frequency's reduction by one-quarter of a set value (Min.) if the input-output difference voltage becomes small or drastic load transient may happen, the OFF period can be caused once in four-cycle period of normal cycle. As a result, the min. OFF time becomes 30 ns (Typ.) against the nominal clock, substantially, and the maximum duty cycle can be improved.



**Bad Frequency (BADFREQ) Protection**

If a current equivalent to 2 MHz (Typ.) or more or 125 kHz (Typ.) or less flows to the RT pin when the resistor of the RT pin is in open / short, the NC2702MA will stop switching to protect the IC and the internal state becomes back to before the soft start. The CLKOUT pin is fixed to "Low" while the bad frequency is detected. The NC2702MA will restart under the normal control with soft start when recover from the abnormal condition.



**BADFREQ Detection / Release Sequence**

## PROTECTION FUNCTION

### Thermal Shutdown

When the junction temperature exceeds the thermal shutdown detection temperature (Typ.130°C), switching stops. Then, this IC will restart when the junction temperature drops below the thermal shutdown release temperature (Typ.110°C). The NC2702MA is a product in which a switching regulator controller chip and high-side/low-side MOSFETs are built in one package, and a thermal shutdown circuit is built into the switching regulator controller chip. High-side and low-side MOSFETs junction temperatures cannot be sensed directly. Also, the temperature rises rapidly, specifically over 16 W loss, the MOSFETs may be damaged before the thermal shutdown. If VIN is 22V or more, please implement protection by the current limit function.

### SW Power Supply (VIN Short) / GND (GND Short) Protection

In addition to normal current limit, the NC2702MA provides the SW power supply / GND short protection to monitor the voltage between the MOSFET's drain and source. Since the current limit function is controlled with a sense resistance, the current limit function cannot work for a shoot-through current through the MOSFETs and an overcurrent by shorten the SW pin to VDD/GND. The detecting current can be calculated by SW shot to VDD/GND detector threshold voltage (MOSFET\_ON-Resistance x Current, Typ.0.43 V).

### Current Limit Function

The current limit function limits the peak current to turn the high-side MOSFET off if the difference between SENSE pin voltage and VOUT\_S pin voltage is over the current limit threshold voltage. The current limit detection method and current limit threshold can be set by connecting external components.

The current limit value is detected with the voltage across a sense resistance connected to the internal inductor connected pin in series. By connecting a high precision resistance, the current limit with high accuracy can be realized. Be careful that the power loss caused by the current and R<sub>SENSE</sub>. The peak current in the current limit inductor can be calculated by the following equation.

$$\text{Peak current in Current limit inductor (A)} = \text{Current limit threshold voltage (mV)} / R_{\text{SENSE}} \text{ (m}\Omega\text{)}$$

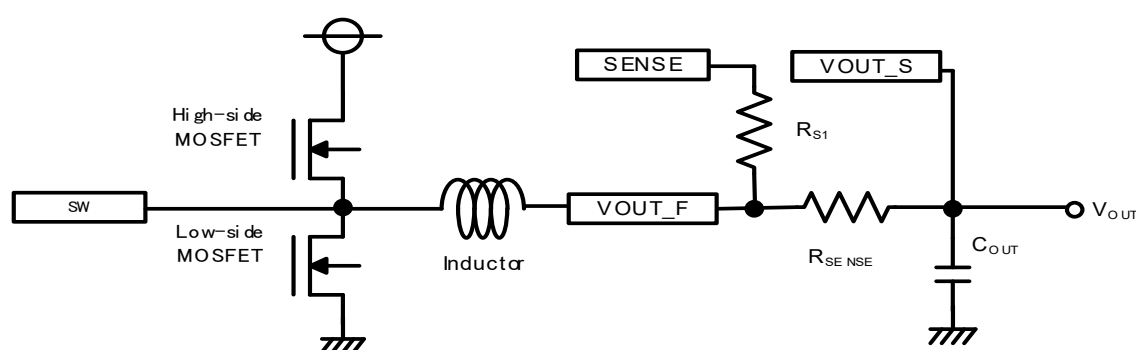


Figure A Detection with Sense Resistance 1

When the load current, I<sub>OUT</sub> is large, the sense resistance, R<sub>SENSE</sub> should be small, in such a case, current limit threshold may shift by the effect of wiring resistance. The countermeasure against it is by connecting R<sub>S1</sub> and R<sub>S2</sub> resistances to SENSE pin shown in Figure B as close as possible to R<sub>SENSE</sub>, the fine current limit level is possible compared with adjustment by only R<sub>SENSE</sub>. In this case, the inductor peak current limit can be calculated by the next equation.

$$\text{Peak Current limit (A)} = \text{Current limit threshold voltage (mV)} / (R_{S0} \times R_{\text{SENSE}} \text{ (m}\Omega\text{)})$$

$$R_{S0} = R_{S2} / (R_{S1} + R_{S2})$$

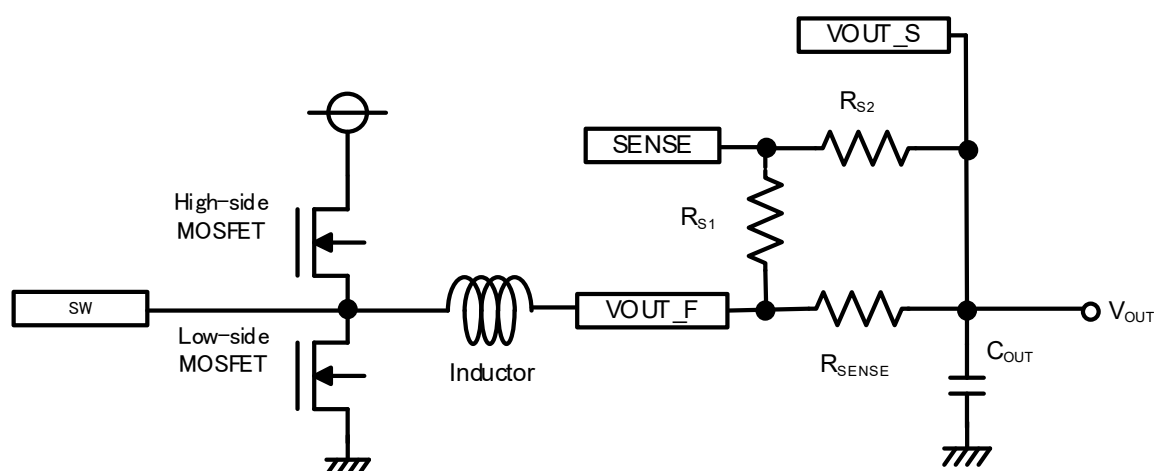


Figure B Detection with Sense Resistance 2

Instead of the SENSE resistor, it is possible to control the current limit value using the DCR of the internal inductor, but it is not recommended due to the drastic deterioration of the accuracy.

### Reverse Current Limit Function

The reverse current limit function works when the reverse current is over the threshold. When the over current beyond the limit is detected, the low-side MOSFET is turned OFF to limit the reverse current. The reverse current limit value is determined by the voltage between the VOUT\_S pin and the SENSE pin. The detector threshold is same as the current limit. This function is useful for the output is shortened to the higher voltage node than the set output voltage.

### Under Voltage Detection (UVD)

The UVD function indirectly monitors the output voltage with using the FB pin. The PG pin outputs "Low" when the UVD detector threshold is 90% (Typ.) of  $V_{FB}$  for more than 30  $\mu s$  (Typ.). When  $V_{FB}$  is over 93% (Typ.) of 0.64 V, the PG pin outputs "High" after the delay time (Typ. 120  $\mu s$ ). The hiccup- / latch-type overcurrent protection works when detecting an overcurrent, an SW shortened to GND, or an over output voltage protection (OVP) during the UVD detection.

### Over Voltage Detection (OVD)

The OVD function indirectly monitors the output voltage with using the FB pin. Switching stops when detecting the over voltage of  $V_{FB}$  but the internal circuit keeps active. The PG pin outputs "Low" when the OVD detector threshold is 110% (Typ.) of  $V_{FB}$  for more than 30  $\mu s$  (Typ.). When  $V_{FB}$  is under 107% (Typ.) of  $V_{FB}$ , which is the OVD released voltage, the switching goes back to the normal and the PG pin outputs "High" after the delay time (Typ. 120  $\mu s$ ). The over voltage protection works when an error is occurred by peripheral circuits for the FB pin such as output feedback resistance network.

**Over Voltage Protection (OVP)**

The OVP function monitors the voltage of VOUT\_S pin to reduce an over voltage when an error is caused in peripheral circuits for the FB pin. Switching stops when  $V_{OUT}$  is over the OVP detector threshold, but the internal circuit keeps active. When  $V_{OUT}$  is under the OVP detector threshold, switching is back to the normal operation. If the UVD for FB pin is detected during the OVP detect state, the error is detected and hiccup- / latch-type protection will work. However, the operation is not guaranteed because the OVP detector threshold is set beyond the absolute maximum rating of the VOUT\_S pin.

**Hiccup-Type / Latch-Type Overcurrent Protection**

There are the hiccup-type / latch-type overcurrent protections. When UVD can work during the current limit or OVP, or the SW short protection to GND. The latch-type protection can release by the following procedure. After removing the cause, set the EN pin to "Low" or tie  $V_{IN}$  input voltage below the UVLO detector threshold and start again. The hiccup type protection stops switching and releases the circuit automatically after the protection delay time (Typ. 3.5 ms). Since the hiccup type protection is auto-release, the EN pin control to release the protection is unnecessary. When the output is shortened to GND, turning on and off is repeated until the abnormal condition is released.

## THERMAL CHARACTERISTICS 1

Thermal characteristics depend on the mounting conditions.  
The following measurement conditions are based on JEDEC STD. 51.

### Measurement Conditions

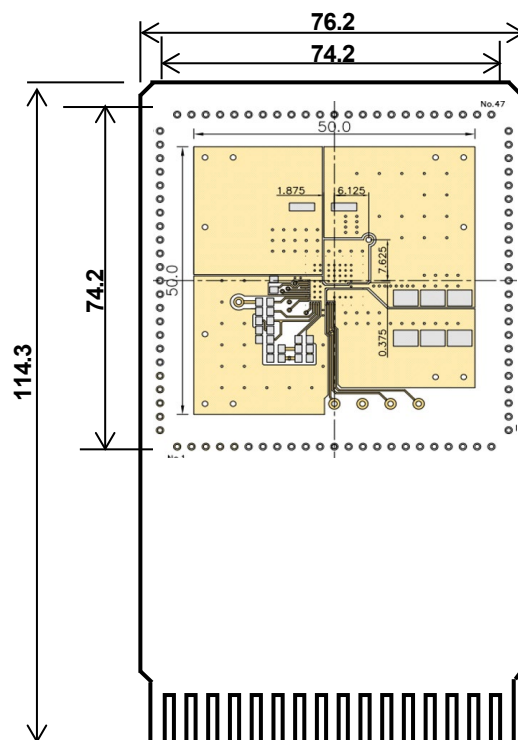
| Parameter        | Measurement Conditions  |
|------------------|---|
| Environment      | Mounting on Board (Wind Velocity = 0 m/s)   |
| Board Material   | Glass Cloth Epoxy Plastic (Four-Layer Board)  |
| Board Dimensions | 76.2 mm × 114.3 mm × 1.6 mm   |
| Copper Ratio     | Outer Layer (First and Fourth Layers) : 90% or more<br>Inner Layers (Second and Third Layers) : 95% or more |

### Measurement Result

| Parameter  | Measurement Result                   |
|--|--------------------------------------|
| Thermal Resistance ( $\theta_{ja}$ )               | $\theta_{ja} = 24^{\circ}\text{C/W}$ |
| Thermal Characterization Parameter ( $\psi_{jt}$ ) | $\psi_{jt} = 6.8^{\circ}\text{C/W}$  |

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



Measurement Board Pattern

## CALCULATION METHOD OF JUNCTION TEMPERATURE

The junction temperature ( $T_j$ ) can be calculated from the following equation.

$$T_j = T_a + \theta_{ja} \times P$$

$$T_j = T_{c(top)} + \psi_{jt} \times P$$

$T_a$ : Ambient temperature.

$T_{c(top)}$ : Package mark side center temperature

$P$ :  $P_{IN} - P_{OUT} = (V_{IN} \times I_{IN}) - (V_{OUT} \times I_{OUT})$  (Power consumption under user's conditions.)

## THERMAL CHARACTERISTICS 2

Thermal characteristics depend on the mounting conditions.

The following thermal characteristics are measurement data using our evaluation board.

### Measurement Conditions

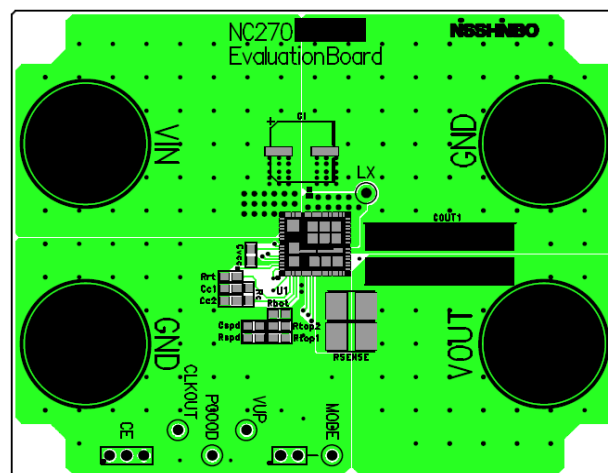
| Parameter        | Measurement Conditions  |
|------------------|---|
| Environment      | Mounting on Board (Wind Velocity = 0 m/s)   |
| Board Material   | Glass Cloth Epoxy Plastic<br>(Four-Layer Board)   |
| Board Dimensions | 70 mm × 90 mm × 1.6 mm  |
| Copper Ratio     | Outer Layer (First and Fourth Layers) :<br>90% or more<br>Inner Layers (Second and Third Layers) :<br>95% or more |

### Measurement Result

| Parameter   | Measurement Result                   |
|---|--------------------------------------|
| Thermal Resistance ( $\theta_{ja}$ )                  | $\theta_{ja} = 16^{\circ}\text{C/W}$ |
| Thermal Characterization<br>Parameter ( $\psi_{jt}$ ) | $\psi_{jt} = 2.41^{\circ}\text{C/W}$ |

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



Measurement Board Pattern

## CALCULATION METHOD OF JUNCTION TEMPERATURE

The junction temperature ( $T_j$ ) can be calculated from the following equation.

$$T_j = T_a + \theta_{ja} \times P$$

$$T_j = T_c(\text{top}) + \psi_{jt} \times P$$

$T_a$ : Ambient temperature.

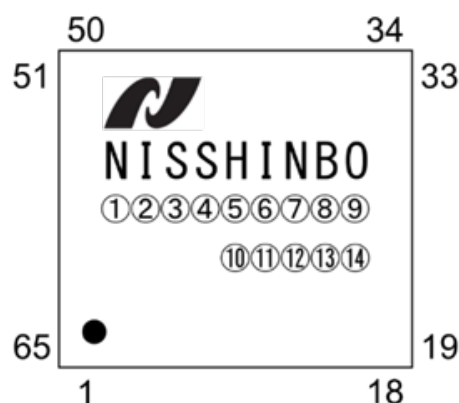
$T_c(\text{top})$ : Package mark side center temperature

$P$ :  $P_{IN} - P_{OUT} = (V_{IN} \times I_{IN}) - (V_{OUT} \times I_{OUT})$  (Power consumption under user's conditions.)

## MARKING SPECIFICATION

①②③④⑤⑥⑦⑧⑨ : Product Code ... Refer to the following table

⑩⑪⑫⑬⑭ : Lot Number ... Alphanumeric Serial Number



## QFN0910-65-MA Part Markings

## NOTICE

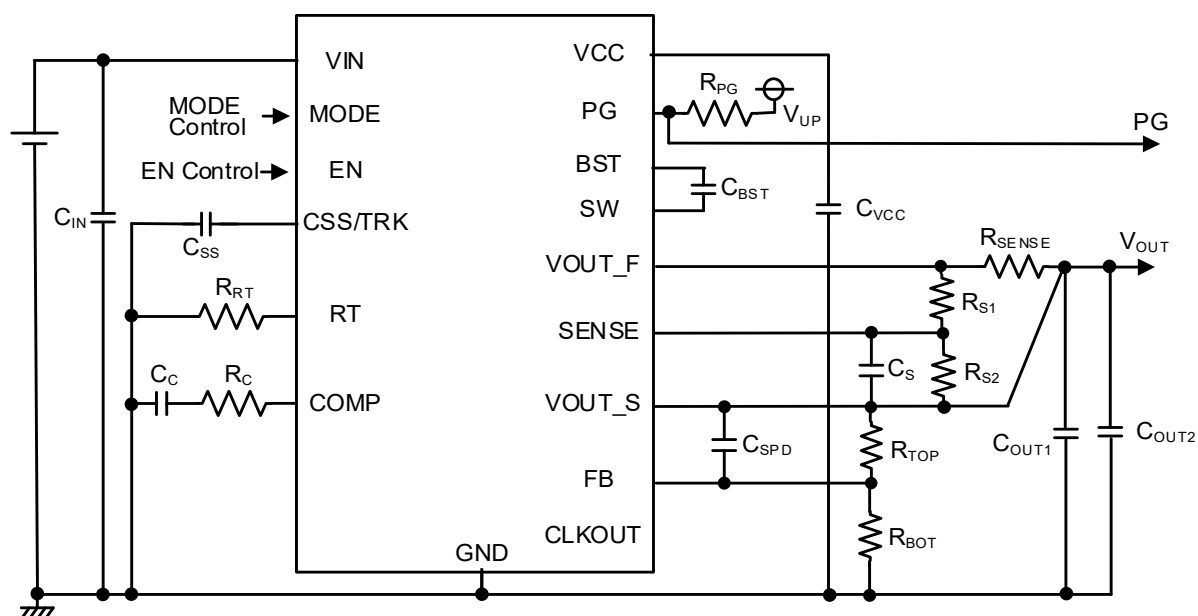
There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or distributor before attempting to use AOI.

## NC2702MA Marking List

| Product Name | ①②③④⑤⑥⑦⑧⑨ |
|--------------|-----------|
| NC2702MA000A | NC2702MAA |
| NC2702MA000B | NC2702MAB |

## APPLICATION NOTE

## Cautions in Selecting External Components



NC2702MA Typical Application Circuit

## Inductor

The inductor built in the NC2702MA:  $L = 2.2 \mu\text{H}$ ,  $\text{DCR} = \text{Typ. } 13.7 \text{ m}\Omega$ .

## Capacitor

Choose a capacitor that has a sufficient margin to the voltage ratings with consideration of the DC bias characteristics and the temperature characteristics.

The use of a ceramic capacitor for  $C_{\text{IN}}$  is recommended. When both a ceramic capacitor and an electrolyte capacitor are used, the stability of the operation will be improved. Choose the electrolyte capacitor with the possible lowest ESR with consideration of the allowable ripple current rating ( $I_{\text{RMS}}$ ).  $I_{\text{RMS}}$  can be calculated by the following equation.

$$I_{\text{RMS}} \approx I_{\text{OUT}} / V_{\text{IN}} \times \sqrt{V_{\text{OUT}} \times (V_{\text{IN}} - V_{\text{OUT}})}$$



## Table of Constants

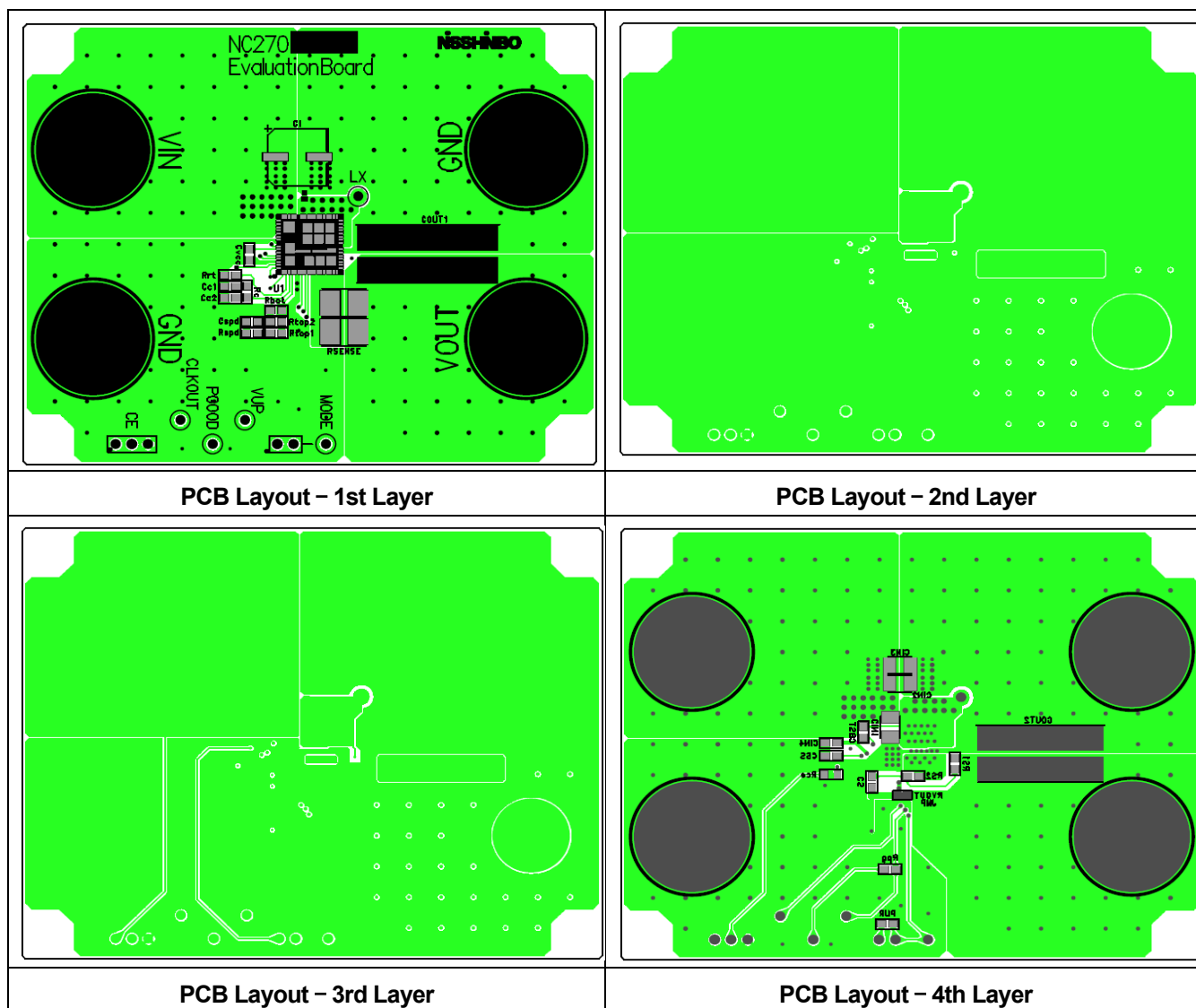
$R_{BOT}=22k\Omega$ ,  $C_{VCC}=2.2\mu F$ ,  $C_{BST}=0.22\mu F$  should be used in all conditions.

## NC2702MA

| $V_{IN}$<br>(V) | $V_{OUT}$<br>(V) | $C_{OUT1}$<br>( $\mu F$ ) | $C_{OUT2}$<br>( $\mu F$ ) | $R_{RT}$<br>( $k\Omega$ ) | $R_C$<br>( $k\Omega$ ) | $C_C$<br>( $\mu F$ ) | $R_{TOP}$<br>( $k\Omega$ ) | $C_{SPD}$<br>(pF) | $C_{SS}$<br>(nF) | $R_{S1}$<br>( $k\Omega$ ) | $R_{S2}$<br>( $k\Omega$ ) | $C_S$<br>(pF) | $R_{SENSE}$<br>(m $\Omega$ ) |
|-----------------|------------------|---------------------------|---------------------------|---------------------------|------------------------|----------------------|----------------------------|-------------------|------------------|---------------------------|---------------------------|---------------|------------------------------|
| 5               | 0.8              | 47*3                      | 120                       | 83.1                      | 6.8                    | 4.7                  | 5.6                        | 330               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 5               | 1                | 47*2                      | 120                       | 83.1                      | 6.8                    | 4.7                  | 12.4                       | 330               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 5               | 1.8              | 47*3                      | -                         | 83.1                      | 4.7                    | 4.7                  | 39.9                       | 220               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 5               | 2.5              | 47*3                      | -                         | 83.1                      | 4.7                    | 4.7                  | 64                         | 100               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 5               | 3.3              | 47*3                      | -                         | 83.1                      | 4.7                    | 4.7                  | 91.4                       | 100               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 12              | 0.8              | 47*3                      | 120                       | 83.1                      | 6.8                    | 4.7                  | 5.6                        | 330               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 12              | 1                | 47*2                      | 120                       | 83.1                      | 6.8                    | 4.7                  | 12.4                       | 330               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 12              | 1.8              | 47*2                      | 120                       | 83.1                      | 4.7                    | 4.7                  | 39.9                       | 220               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 12              | 2.5              | 47*3                      | -                         | 83.1                      | 6.8                    | 4.7                  | 64                         | 100               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 12              | 3.3              | 47*2                      | -                         | 65.9                      | 6.8                    | 4.7                  | 91.4                       | 100               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 12              | 5                | 47*2                      | -                         | 54.5                      | 6.8                    | 4.7                  | 150                        | 68                | 3.3              | 1k                        | -                         | 100           | 6                            |
| 24              | 3.3              | 47*2                      | -                         | 54.5                      | 8.2                    | 2.2                  | 91.4                       | 100               | 3.3              | 1k                        | -                         | 100           | 6                            |
| 24              | 5                | 47*2                      | -                         | 40.5                      | 8.2                    | 2.2                  | 150                        | 68                | 3.3              | 1k                        | -                         | 100           | 6                            |

※The "-" indicate OPEN.

Evaluation Board / PCB Layout

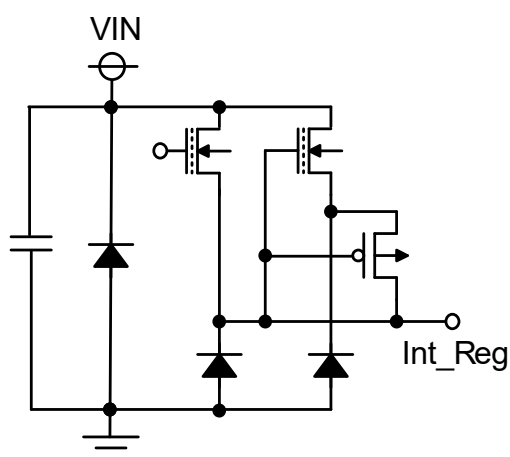


## Technical Notes

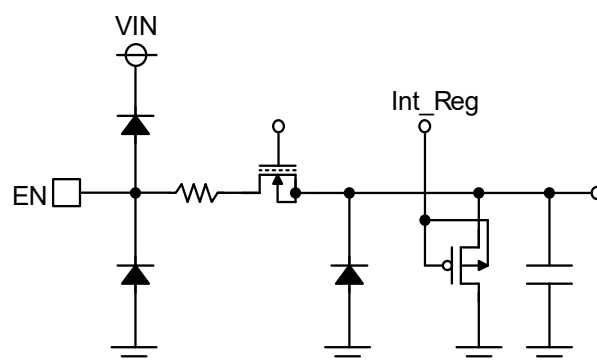
The performance of power source circuits using this IC largely depends on peripheral circuits. When selecting the peripheral components, please consider the conditions of use. Do not allow each component, PCB pattern or the IC to exceed their respected rated values (voltage, current, and power) when designing the peripheral circuits.

- External components must be connected as close as possible to the ICs and make wiring as short as possible. Especially, the capacitor connected in between VIN pin and GND pin must be wiring the shortest. If their impedance is high, internal voltage of the IC may shift by the switching current, and the operating may be unstable. Make the power supply and GND lines sufficient.
- Put a capacitor ( $C_{OUT}$ ) to keep a distance from  $C_{IN}$  to avoid the high-frequency noise by input.
- Put a capacitor ( $C_{BST}$ ) as close as possible to the SW pin and the BST pin. If controlling a slew rate of the high-side MOSFET for EMI, a resistor ( $R_{BST}$ ) should be in series between the BST pin and the capacitor ( $C_{BST}$ ).
- Do not use the MODE pin with “open” or “Low”.
- If  $V_{OUT}$  is a negative voltage, start-up may not impossible.
- The thermal shutdown function prevents the IC from fuming and ignition but does not ensure the IC's reliability or keep the IC below the absolute maximum ratings. The thermal shutdown function does not operate on the heat generated by other than the normal IC operation such as latch-up and overvoltage application.
- The thermal shutdown function operates in state over the absolute maximum ratings; therefore, the thermal shutdown function should not be used for a system design.
- The connection between GND pins should be near the IC in common to avoid impedance difference.
- When the load current,  $I_{OUT}$  is large, the sense resistance,  $R_{SENSE}$  should be small, in such a case, current limit threshold may shift by the effect of wiring resistance. The countermeasure against it is by connecting  $R_{S1}$  and  $R_{S2}$  resistances to SENSE pin as close as possible to  $R_{SENSE}$ . Refer to the explanation of “Current Limit Function”.
- As a noise filter, setting a capacitor,  $C_S$  between SENSE pin and  $V_{OUT\_S}$  as close as possible to the IC is also recommended.

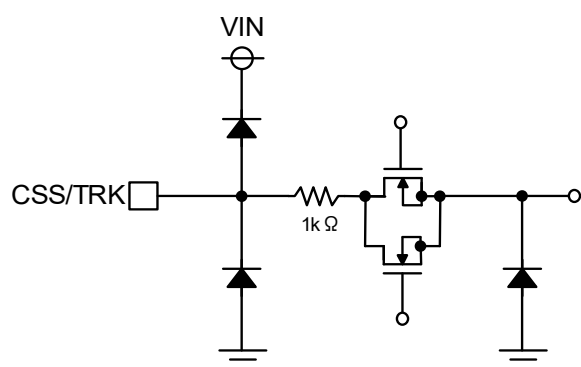
INTERNAL EQUIVALENT CIRCUIT FOR EACH PIN



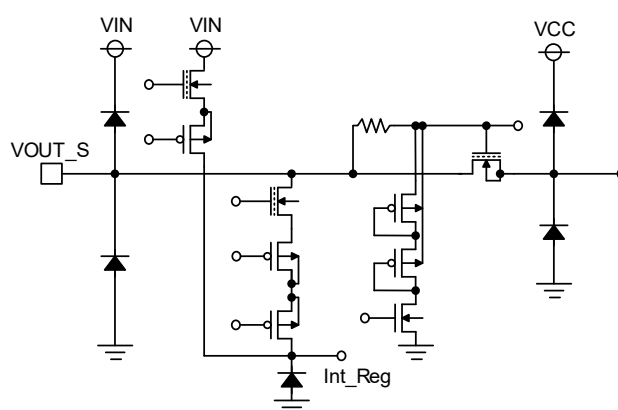
VIN Pin



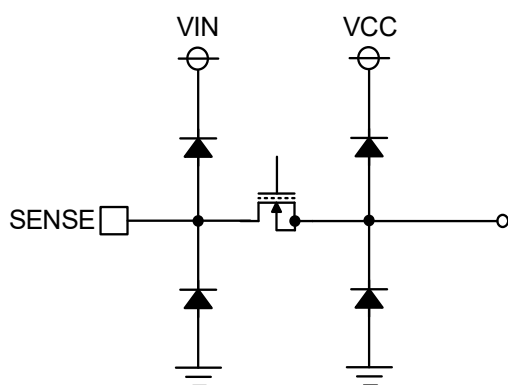
EN Pin



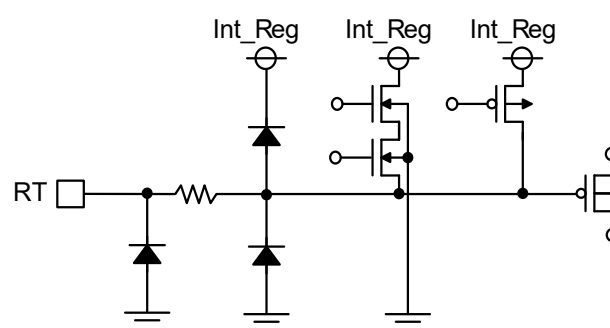
CSS/TRK Pin



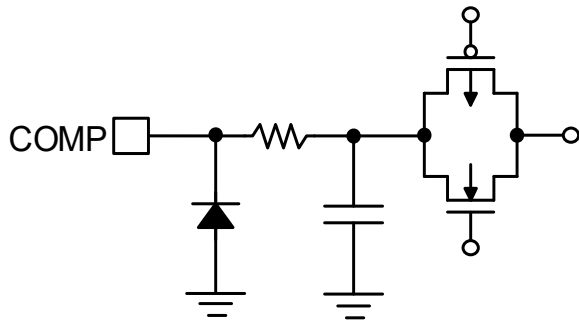
VOUT\_S Pin



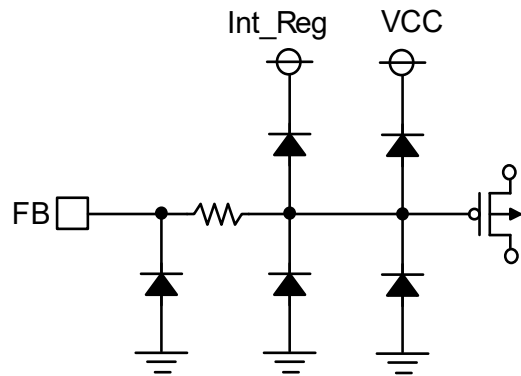
SENSE Pin



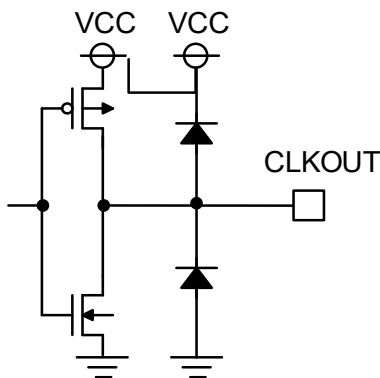
RT Pin



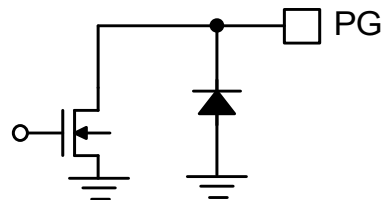
COMP Pin



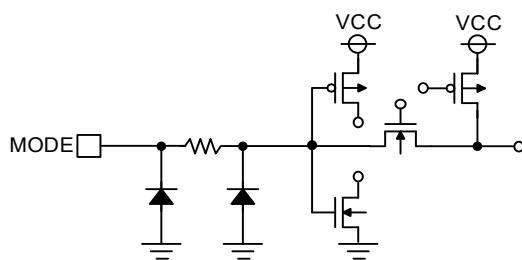
FB Pin



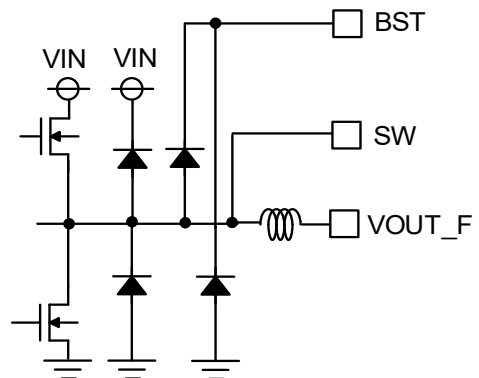
CLKOUT Pin



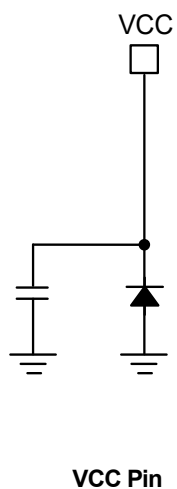
PG Pin



MODE Pin



SW Pin, VOUT\_F, BST Pin



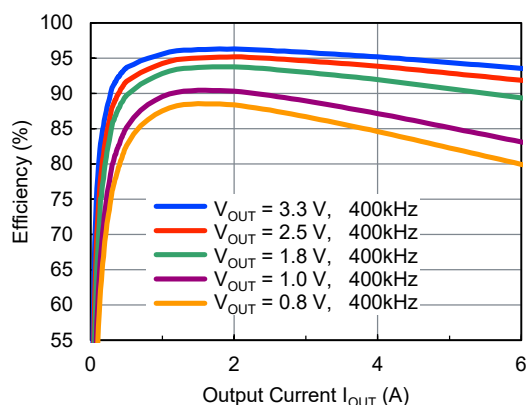
# TYPICAL CHARACTERISTICS

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

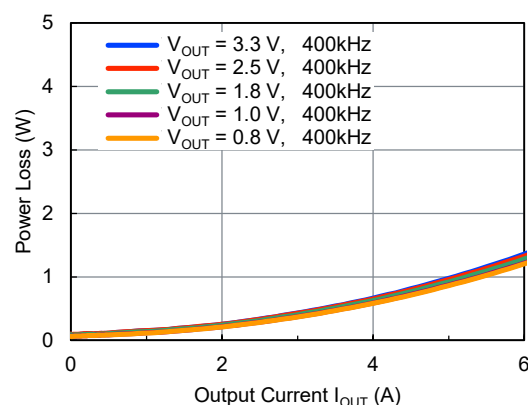
## 1) Efficiency and Power Loss vs Output Current

$V_{IN} = 5\text{ V}$

Efficiency vs Output Current

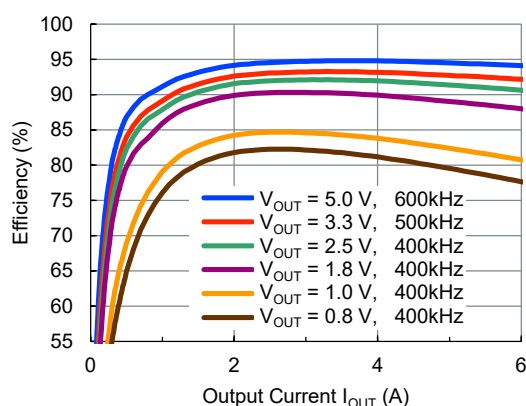


Power Loss vs Output Current

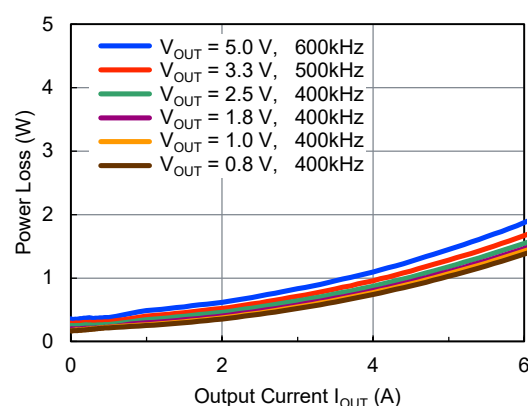


$V_{IN} = 12\text{ V}$

Efficiency vs Output Current

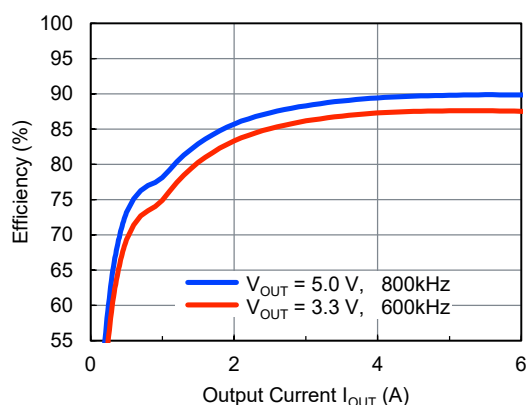


Power Loss vs Output Current

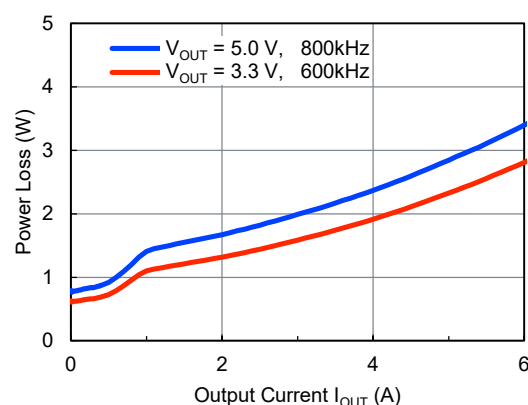


$V_{IN} = 24\text{ V}$

Efficiency vs Output Current

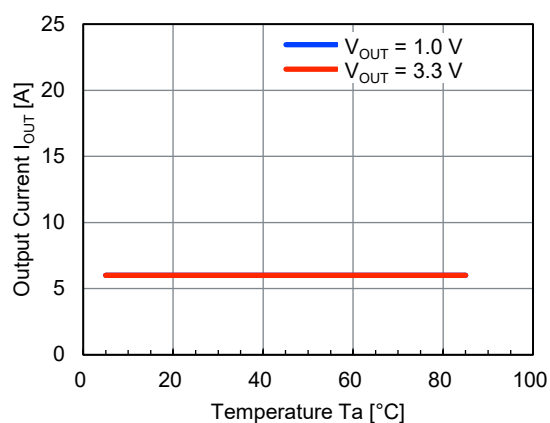


Power Loss vs Output Current

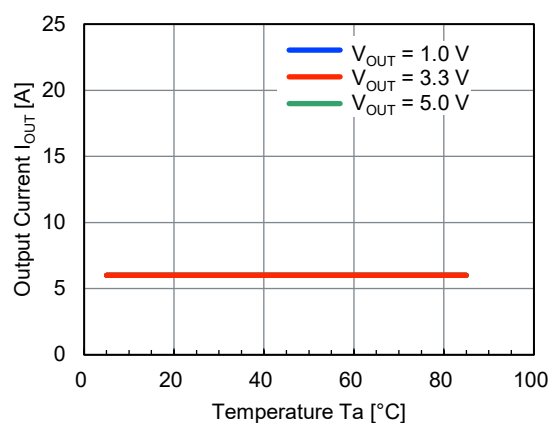


## 2) Maximum Current Temperature Dearing

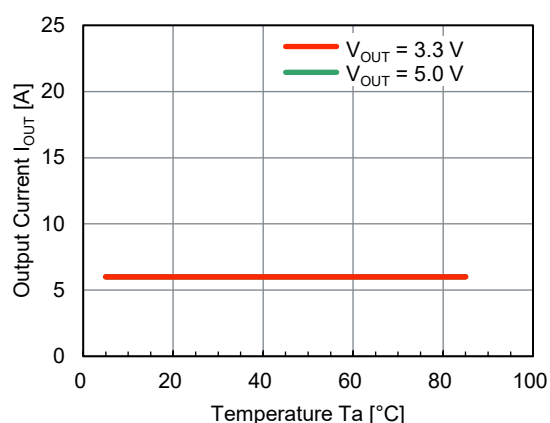
$V_{IN} = 5\text{ V}$



$V_{IN} = 12\text{ V}$



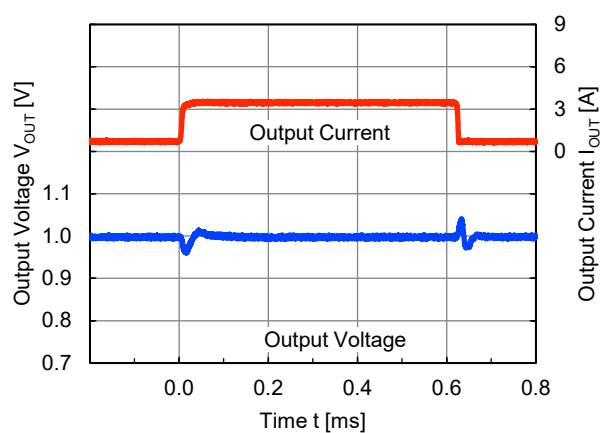
$V_{IN} = 24\text{ V}$



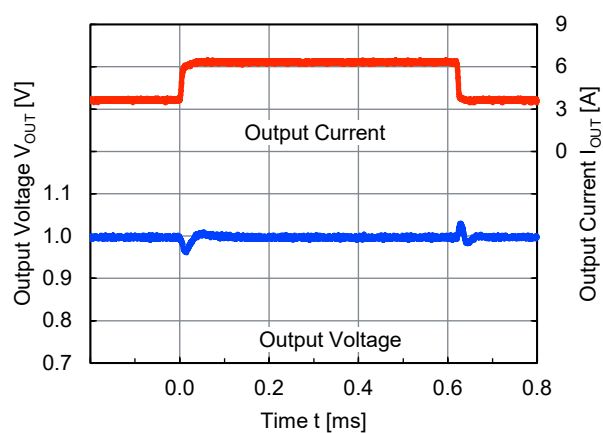
## 3) Load Transient Response

$V_{IN} = 5\text{ V}$ ,  $V_{OUT} = 1\text{ V}$

$I_{OUT} = 0\text{ A} \leftrightarrow 3\text{ A}$

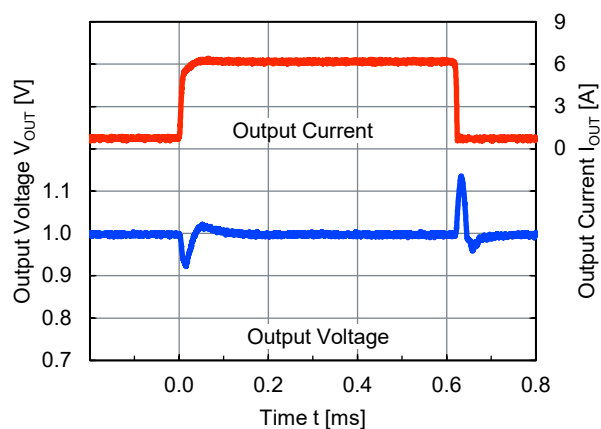


$I_{OUT} = 3\text{ A} \leftrightarrow 6\text{ A}$



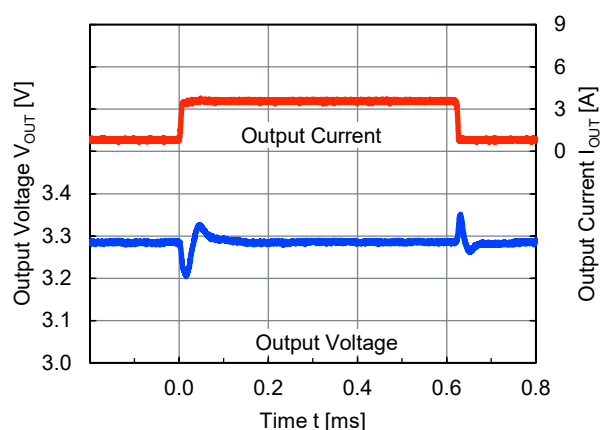


$I_{OUT} = 0\text{ A} \Leftrightarrow 6\text{ A}$

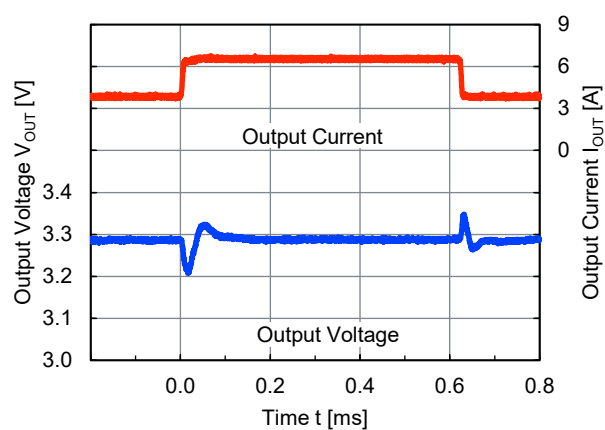


$V_{IN} = 5\text{ V}, V_{OUT} = 3.3\text{ V}$

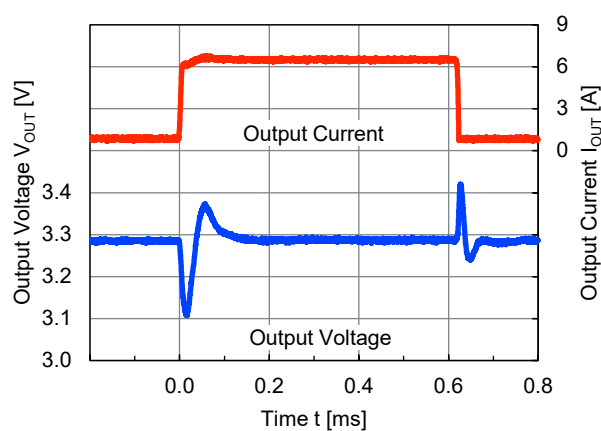
$I_{OUT} = 0\text{ A} \Leftrightarrow 3\text{ A}$



$I_{OUT} = 3\text{ A} \Leftrightarrow 6\text{ A}$

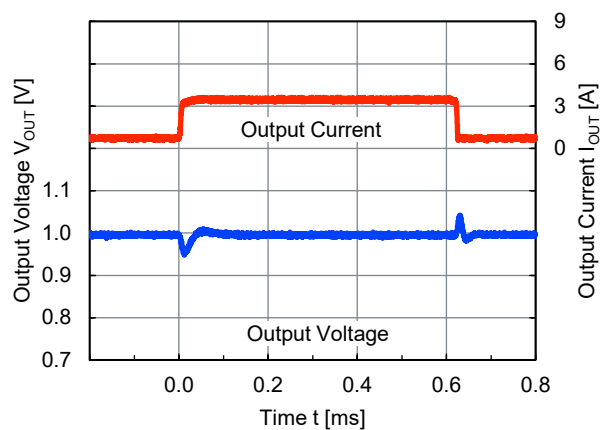


$I_{OUT} = 0\text{ A} \Leftrightarrow 6\text{ A}$

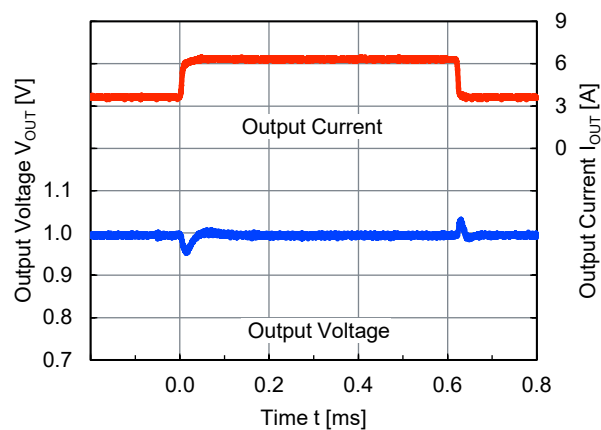


$V_{IN} = 12\text{ V}$ ,  $V_{OUT} = 1\text{ V}$

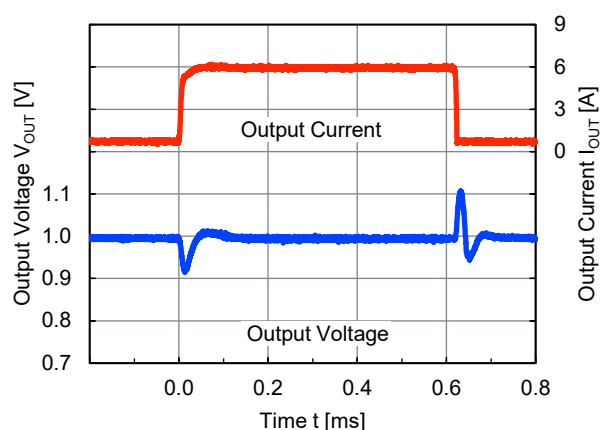
$I_{OUT} = 0\text{ A} \Leftrightarrow 3\text{ A}$



$I_{OUT} = 3\text{ A} \Leftrightarrow 6\text{ A}$

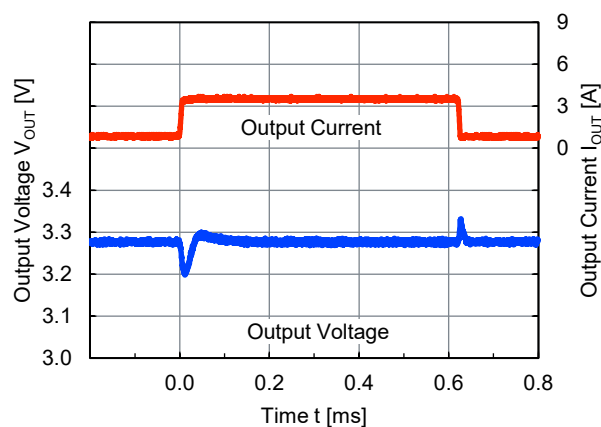


$I_{OUT} = 0\text{ A} \Leftrightarrow 6\text{ A}$

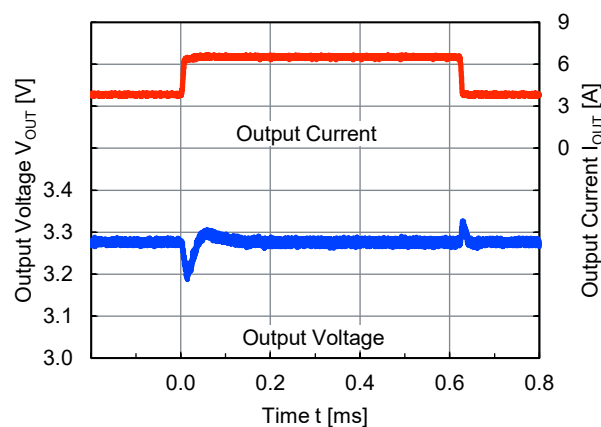


$V_{IN} = 12\text{ V}$ ,  $V_{OUT} = 3.3\text{ V}$

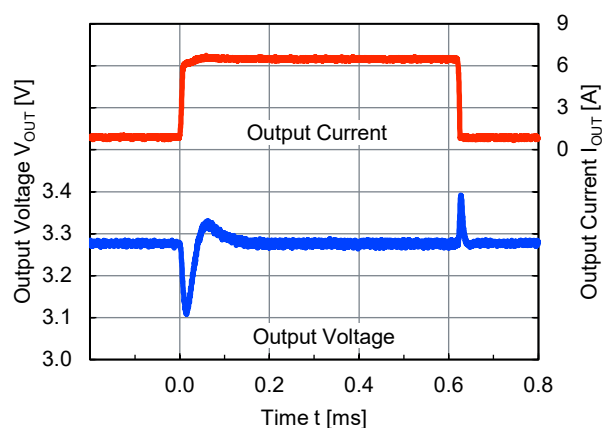
$I_{OUT} = 0\text{ A} \Leftrightarrow 3\text{ A}$



$I_{OUT} = 3\text{ A} \Leftrightarrow 6\text{ A}$



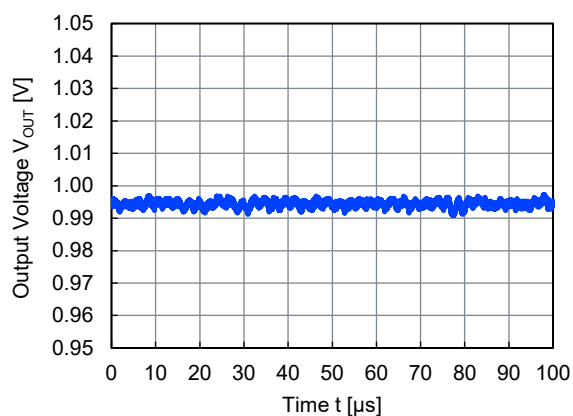
$I_{OUT} = 0\text{ A} \leftrightarrow 6\text{ A}$



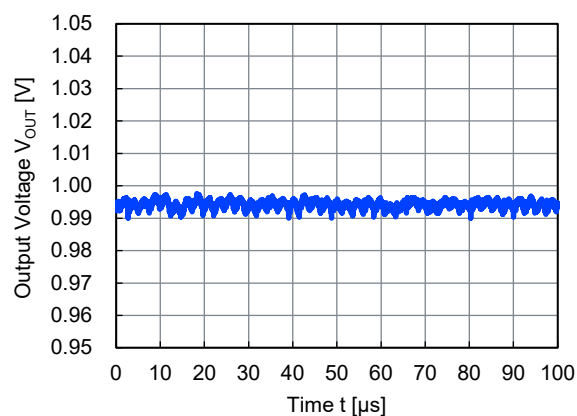
#### 4) Output Voltage vs Time

$V_{IN} = 12\text{ V}$ ,  $V_{OUT} = 1\text{ V}$

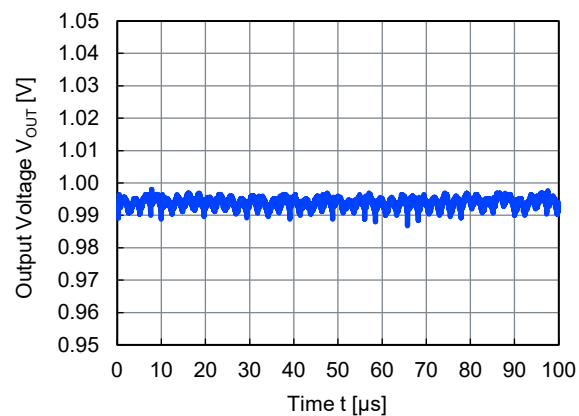
$I_{OUT} = 0\text{ A}$



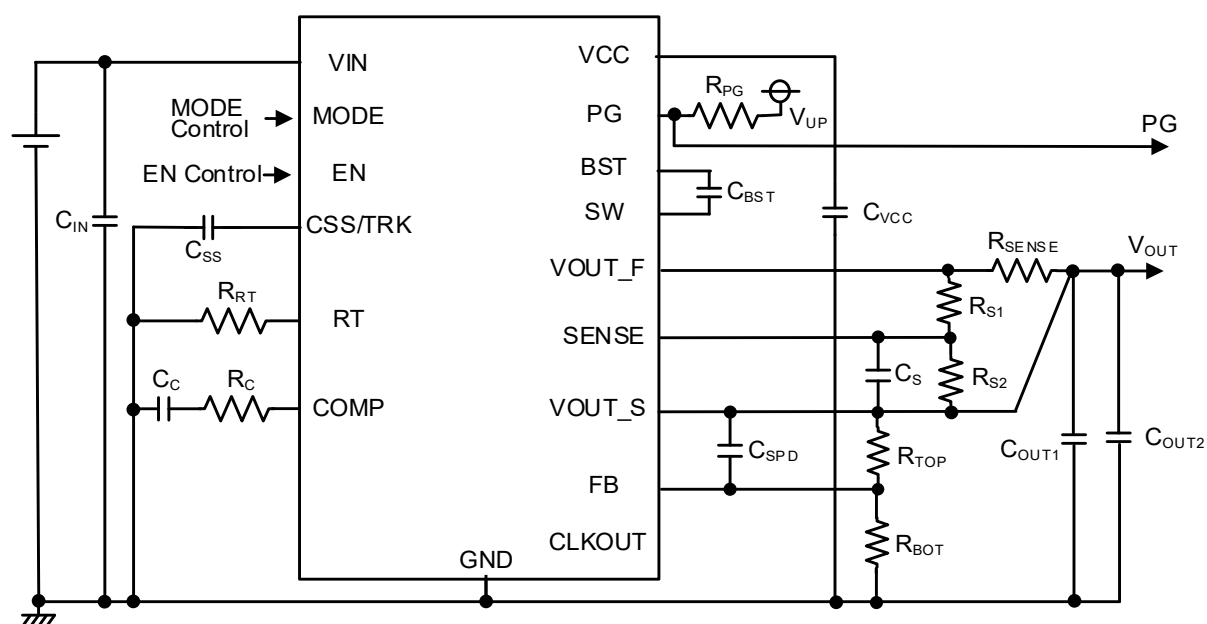
$I_{OUT} = 3\text{ A}$



$I_{OUT} = 6\text{ A}$



## TEST CIRCUIT



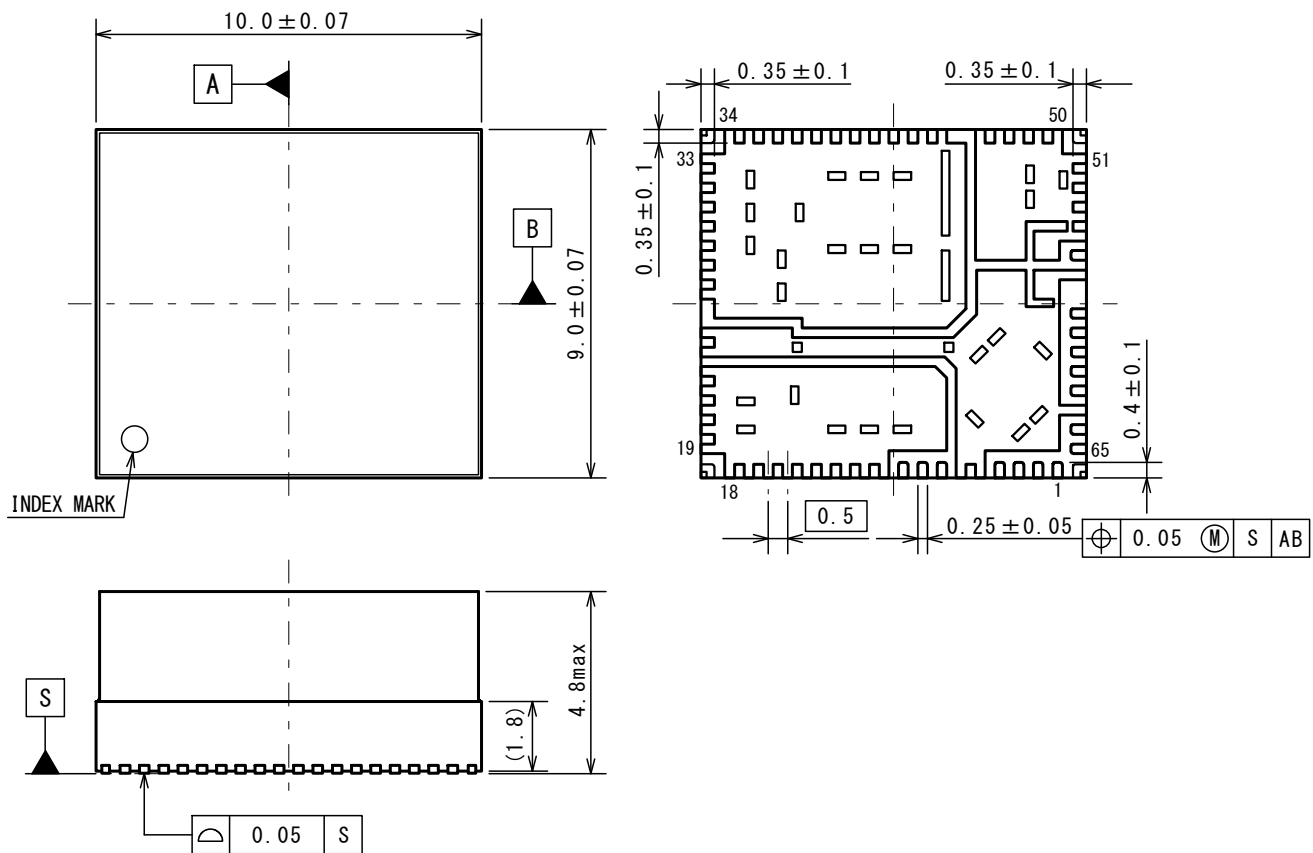
NC2702MA Test Circuit

## Components List

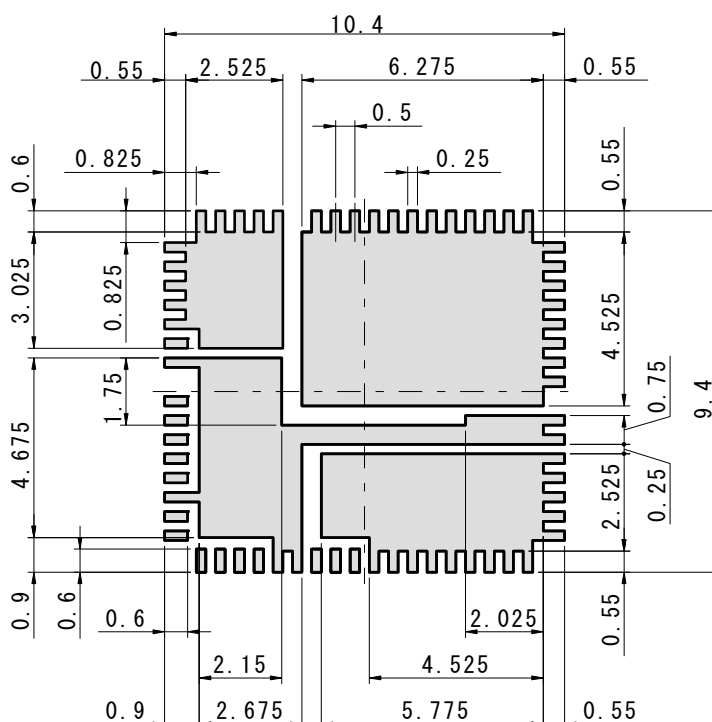
| Symbol            | Specification | Parts Number       |
|-------------------|---------------|--------------------|
| C <sub>IN</sub>   | 10 $\mu$ F    | CGA6P3X7S1H106K    |
| C <sub>OUT1</sub> | 47 $\mu$ F    | C3225X7S1A476M     |
| C <sub>OUT2</sub> | 120 $\mu$ F   | EEFSX0J121E7       |
| C <sub>VCC</sub>  | 2.2 $\mu$ F   | GCM21BR71E225KA73L |
| C <sub>BST</sub>  | 0.22 $\mu$ H  | GCM188R71E224KA55D |

## ■ PACKAGE DIMENSIONS

UNIT: mm



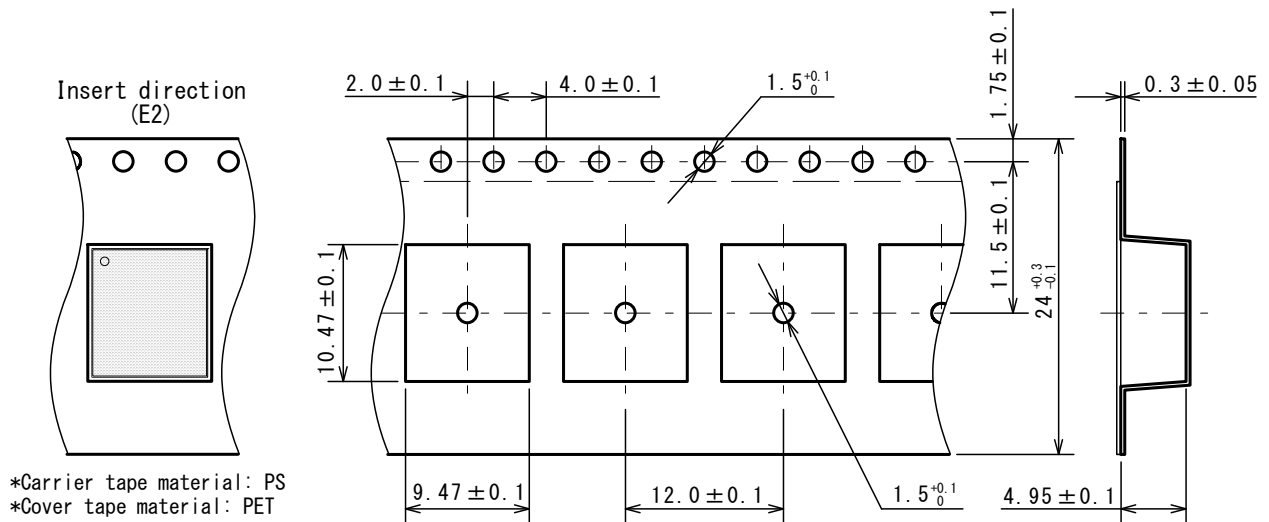
## ■ EXAMPLE OF SOLDER PADS DIMENSIONS



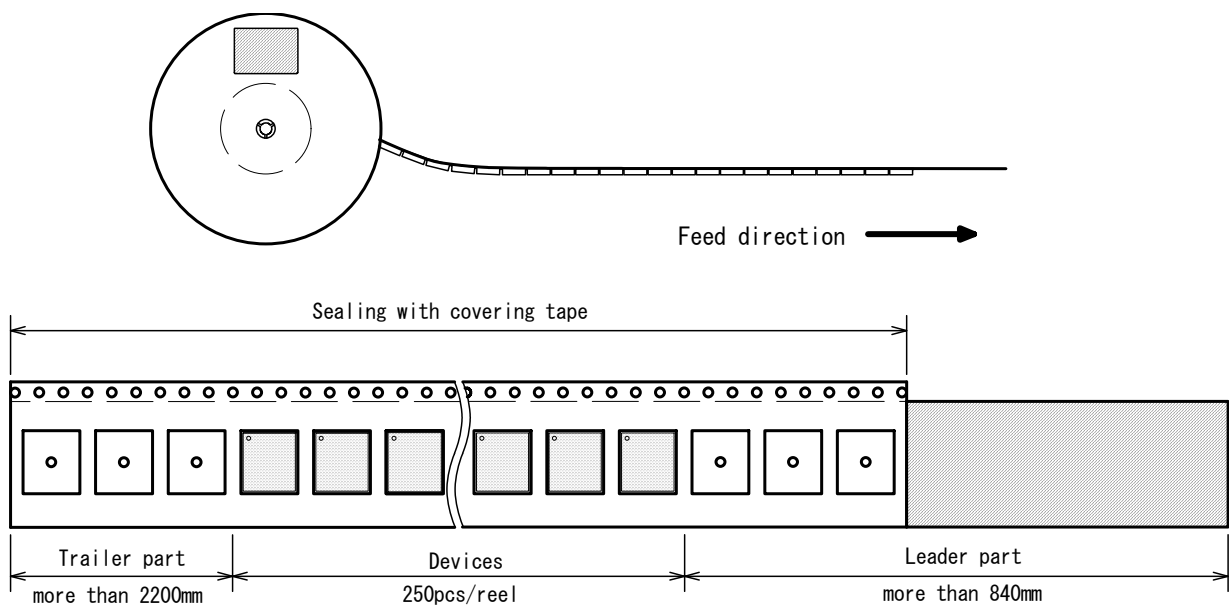
## ■ PACKING SPEC

UNIT: mm

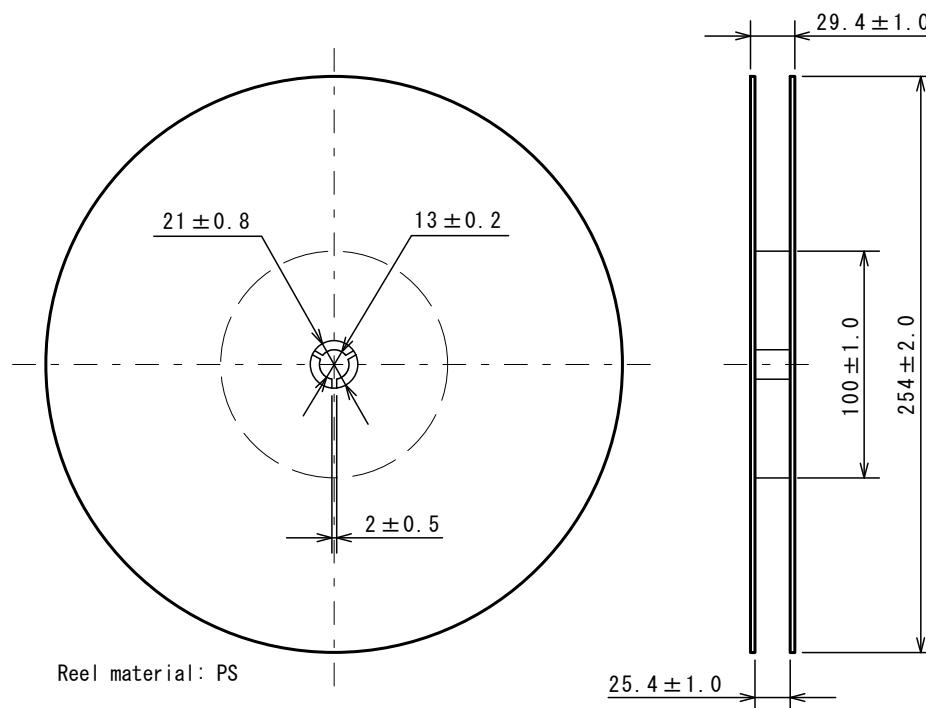
(1) Taping dimensions / Insert direction



(2) Taping state



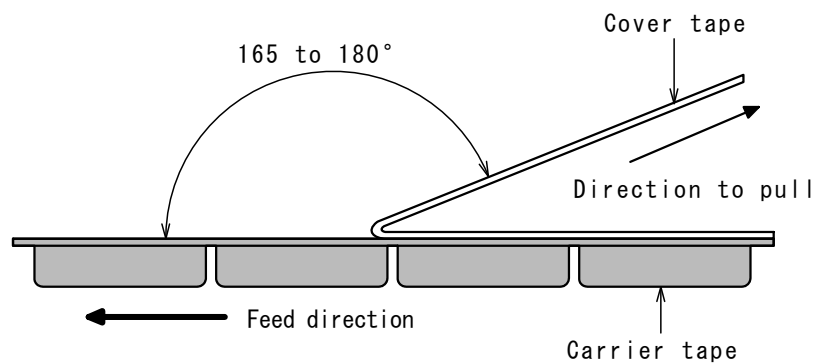
## (3) Reel dimensions



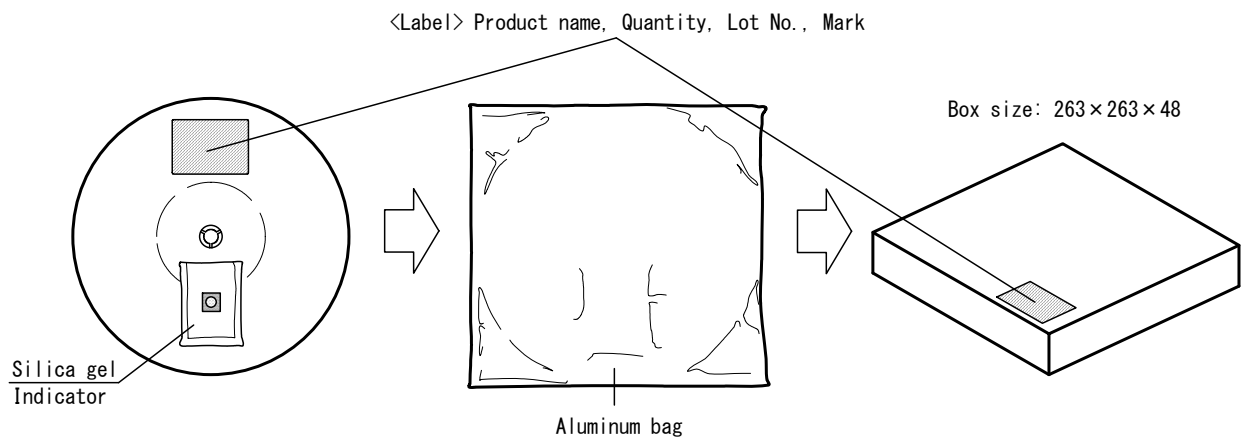
## (4) Peeling strength

Peeling strength of cover tape

- Peeling angle 165 to 180° degrees to the taped surface.
- Peeling speed 300mm/min
- Peeling strength 0.1 to 1.3N

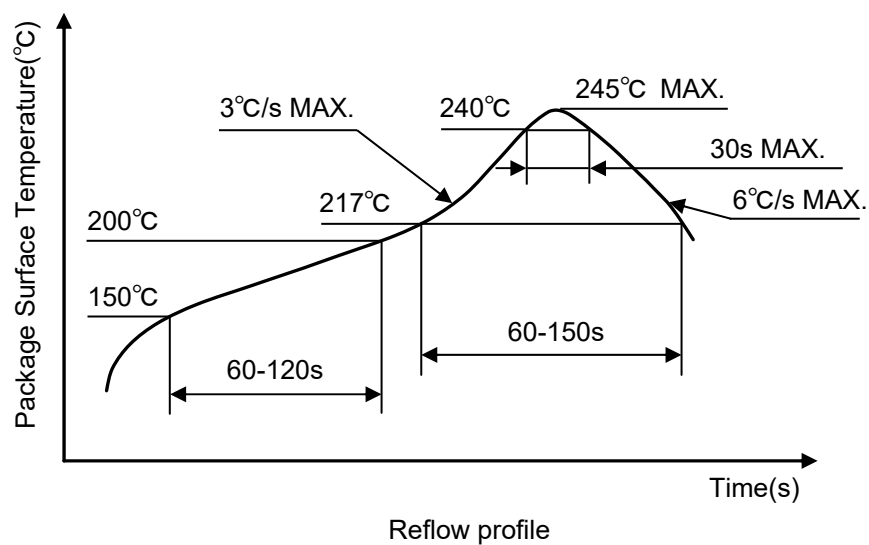


## (5) Packing state



## ■ HEAT-RESISTANCE PROFILES

Reflow and Repair soldering method shall be within three times.





## ■ STORAGE CONDITION

### 1. Storage conditions

|                |              |              |
|----------------|--------------|--------------|
| Before opening | Temperature: | 5 to 40 (°C) |
|                | Humidity:    | 45 to 90 (%) |
| After opening  | Temperature: | 5 to 30 (°C) |
|                | Humidity:    | 45 to 60 (%) |

Be sure to use within 1weeks (168h) after the open the anti-humidity seal.

### 2. Notes of IC storage

- (1) Do not use water for the tap for humidifiers, but use pure water or boiled water.
- (2) Do not store the devices in a corrosive-gas atmosphere.
- (3) Do not store the devices in a dusty place.
- (4) Do not expose devices to direct sunlight.
- (5) Maintain the temperature of the storage place stabilized.
- (6) Keep away from excessive load and impact.
- (7) Keep away from excessive electromagnetic radiation exposure.
- (8) When storing the tape packaging product which is used partially, do not roll up with excessive tension because it can influence the taping quality.

### 3. Storage period

Please mount devices within a year after delivering.

For the devices have stored longer than a year, check the corrosion of leads and solderability before using.

### 4. Baking Requirements

Baking prior to soldering reflow is required if the above storage term has been exceeded.

This package has a structure that makes it difficult to dehumidify. Please bake under the following baking conditions.

Baking condition at **125°C for 72hrs** should be used.

However, the tape and reel of the taping package of this product are not heat resistant.

Transfer to a heat-resistant container with a temperature of 125°C or higher before use.

#### <Notes>

Baking is limited to two times.

If more than three times baking is performed, be sure to confirm the solderability before use.

Package cracks may occur when reflow mounting a product that has absorbed moisture.

### 5. Moisture Sensitivity Levels

JEDEC: Level 3

**Revision History**

| Date        | Revision | Contents of Changes |
|-------------|----------|---------------------|
| Jun.12.2023 | Ver. 1.0 | Initial release     |

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2. The materials in this document may not be copied or otherwise reproduced in whole or in part without the prior written consent of us.
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  - Aerospace Equipment
  - Equipment Used in the Deep Sea
  - Power Generator Control Equipment (nuclear, steam, hydraulic, etc.)
  - Life Maintenance Medical Equipment
  - Fire Alarms / Intruder Detectors
  - Vehicle Control Equipment (automotive, airplane, railroad, ship, etc.)
  - Various Safety Devices
  - Traffic control system
  - Combustion equipment

In case your company desires to use this product for any applications other than general electronic equipment mentioned above, make sure to contact our company in advance. Note that the important requirements mentioned in this section are not applicable to cases where operation requirements such as application conditions are confirmed by our company in writing after consultation with your company.

6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. The products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this datasheet. Failure to employ the products in the proper applications can lead to deterioration, destruction or failure of the products. We shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of the products.
8. **Quality Warranty**
  - 8-1. **Quality Warranty Period**  
In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
  - 8-2. **Quality Warranty Remedies**  
When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.  
Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
  - 8-3. **Remedies after Quality Warranty Period**  
With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
9. Anti-radiation design is not implemented in the products described in this document.
10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



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